

Sample & Buy



TPS65400-Q1

ZHCSDX6-JULY 2015

Technical

Documents

单元

特性 1

- 符合汽车应用要求
- 具有符合 AEC-Q100 的下列结果:
 - 器件温度 1 级: -40°C 至 125°C 的环境运行温 度范围
 - 器件人体放电模式 (HBM) 静电放电 (ESD) 分类 等级 H2
 - 器件组件充电模式 (CDM) ESD 分类等级 C4B
- 每个开关稳压器的效率高达 95%
- 开关稳压器规范:
 - 输入电压范围: 4.5V 至 18V
 - 输出电压范围: 0.6V 至输入电压的 90%
 - SW1 和 SW2 的输出电流:最大 4A
 - SW3 和 SW4 的输出电流:最大 2A
- 预偏置启动算法以最大程度减小了启动期间的压降
- 内部欠压闭锁 (UVLO)、过流保护 (OCP)、过压保 护 (OVP) 和过温保护 (OTP)
- 散热增强型 7mm × 7mm 48 引脚 0.5mm 间距超薄 型四方扁平无引线 (VQFN) 封装
- 提供的引脚功能:
 - 可通过外部反馈电阻调节输出电压
 - 通过精确使能引脚定序控制每个开关
 - 可通过电阻在 275kHz 至 2.2MHz 范围内调节 PWM 开关频率
 - 时钟同步输入和时钟输出
 - 通过外部电容器设置软启动延迟
 - 必要时可通过 SW1 和 SW2 之间以及 SW3 和 SW4 之间的电流均流功能满足高电流需求
- PMBus 运行时控制和状态
 - 通过调整 V_{RFF} 实现运行时电压定位
 - 使能和禁用每个开关
 - 故障和状态监视
- 用户可配置的 PMBus/I²C 选项,保存在 EEPROM 中
 - 电源接通和关断排序
 - 可基于固定时间延迟或 PGOOD 实现电源排序
 - 通过 VREF 配置实现初始电压定位
 - 针对每个开关调节 PWM 频率
 - 针对每个开关单独进行 PWM 相位对齐以尽可

- 能减小纹波和电容器尺寸
- 可调节每个稳压器的电流限制以优化电感器的尺 寸和成本

Support &

Community

2.2

- 软启动时间

🥖 Tools &

Software

2 应用

- 符合汽车应用要求 •
- 小型蜂窝基站 (BTS) (例如: 微微蜂窝和微蜂 窝); 宏蜂窝 BTS (使用多个 PMU)
- 以太网供电 (PoE) 通信基础设备
- 为数字信号处理器 (DSP) 和 MCU 供电
- 工业与工厂自动化 •
- 具有小尺寸、高效率、高工作环境温度和灵活电源 • 管理等要求的系统

3 说明

TPS65400-Q1 是一款集成型电源管理单元 (PMU), 针 对小尺寸和高电源转换效率要求的应用进行了优化,使 得小型空间受限类设备能够在高温环境下工作而无需制 冷。此器件可借助优化的稳压器组合从中间配电母线 进行单级转换,从而在系统级实现高能效。

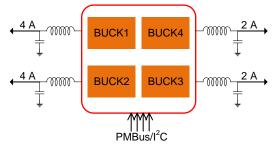
器件信息(1)

| 器件型号 | 封装 | 封装尺寸(标称值) |
|-------------|-----------|-----------------|
| TPS65400-Q1 | VQFN (48) | 7.00mm x 7.00mm |
| | | |

(1) 要了解所有可用封装,请见数据表末尾的可订购产品附录。

简化电路原理图

Vin: 4.5 to 18 V





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4 修订历史记录

| 日期 | 修订版本 | 注释 |
|------------|------|-------|
| 2015 年 7 月 | * | 首次发布。 |



5 说明(续)

TPS65400-Q1 实现了兼容 PMBus/l²C 的数字接口。此接口可在运行时更改稳定电压、电源排序、相位交错、工作频率以及读回工作状态等,从而帮助内核芯片优化系统性能。

TPS65400-Q1 包含 4 个具有集成场效应晶体管 (FET) 的高电流降压开关稳压器(SW1、SW2、SW3 和 SW4)。 这些开关电源专门用于为高电流数字电路(例如处理器、现场可编程门阵列 (FPGA)、专用集成电路 (ASIC)、存储 器和数字输入/输出 (I/O))供电。SW1 和 SW2 支持 4A 电流,而 SW3 和 SW4 支持 2A 电流。每个稳压器的开 关频率可单独调节,最高可调节至 2.2MHz。

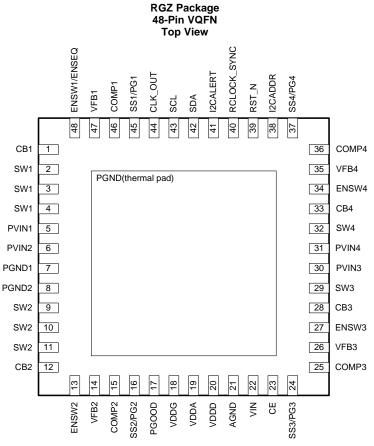
每个开关均具有可编程的限流功能,因此可为无需最大电流能力的特定应用配置优化电感器额定值。

TPS65400-Q1 可由 4.5V 和 18V 之间的单输入电压轨供电,因此非常适合由 5V 或 12V 中间电源配电母线供电运行的应用。

可使用各个使能引脚或者通过 I²C 总线将序列编程到板载 EEPROM 中来满足电源排序要求。 输出电压可通过外部 电阻网络进行设置, VREF 的可编程范围介于 0.6V 到 1.87V 之间(以 10mV 为单位增量)。 所有控制和状态信息 均可通过兼容 PMBus 的 I²C 总线进行访问。

TPS65400-Q1 极具灵活性,可通过 I²C 总线提供全方位的监视和控制,同时还能够为不使用 I²C 的系统提供电压 以及基于外部元件实现的可编程性。

6 Pin Configuration and Functions



A. Thermal pad must be soldered to PCB as SW3 and SW4 power ground

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Pin Functions

| PIN | | DESCRIPTION |
|-------------|-----|---|
| NAME | NO. | DESCRIPTION |
| CB1 | 1 | Bootstrap pin for high-side MOSFET gate drive for SW1 |
| | 2 | |
| SW1 | 3 | Switch pin for SW1 |
| | 4 | |
| PVIN1 | 5 | Power input for buck switching regulator SW1 |
| PVIN2 | 6 | Power input for SW2 |
| PGND1 | 7 | Power ground for buck converters |
| PGND2 | 8 | Power ground for buck converters |
| | 9 | |
| SW2 | 10 | Switch pin for SW2 |
| | 11 | |
| CB2 | 12 | Bootstrap pin for SW2 high-side MOSFET gate drive |
| ENSW2 | 13 | Enable input pin for SW2. Active high. 2-µA internal pullup current is inside. |
| VFB2 | 14 | Feedback input pin for SW2 |
| COMP2 | 15 | Compensation pin for external compensation network for SW2. Pulling this line high to VDDD configures the SW1 controller to control both SW1 and SW2. |
| SS2/PG2 | 16 | Soft-start for SW2 (default). A capacitor is used to set the startup time. This pin can also be reconfigured through I ² C to display the PGOOD2 signal instead. |
| PGOOD | 17 | Default PGOOD signal is for all switchers. It can be changed according to (D2h) PIN_CONFIG_00. If all switchers are disabled, PGOOD is low. |
| VDDG | 18 | Supply for gate drives. Bypass locally to PGND. |
| VDDA | 19 | Output of internal regulator for analog controls. |
| VDDD | 20 | 3.3-V output of internal regulator digital controls |
| AGND | 21 | Ground connection for analog controls |
| VIN | 22 | Analog V _{IN} . Power input pin for VDDD, VDDA, and VGATE subregulator power |
| CE | 23 | Chip enables. Internal pull-up current will default to high if the pin is left floating. Connect to an open-drain output to pull low to disable. Driving with a push-pull output is not recommended. When low, internal regulators are shutdown to minimize power, and functionsa are disabled. Configuration is reloaded from EEPROM as part of the power-up sequence when CE goes high. |
| SS3/PG3 | 24 | Soft-start for SW3 (default). A capacitor is used to set the startup time. This pin can also be reconfigured through I ² C to display the PGOOD3 signal instead. |
| COMP3 | 25 | Compensation pin for external compensation network for SW3 |
| VFB3 | 26 | Feedback input pin for SW3 |
| ENSW3 | 27 | Enable input pin for SW3. Active high. 2-µA internal pullup current is inside. |
| CB3 | 28 | Bootstrap pin for SW3 high-side MOSFET gate drive |
| SW3 | 29 | Switch pin for SW3. Max rated output current is 2 A. |
| PVIN3 | 30 | Power input for buck switching regulator SW3 |
| PVIN4 | 31 | Power input for SW4 |
| SW4 | 32 | Switch pin for SW4. Max rated output current is 2 A. |
| CB4 | 33 | Bootstrap pin for SW4 high-side MOSFET gate drive |
| ENSW4 | 34 | Enable input pin for SW4. Active high. 2-µA internal pullup current is inside. |
| VFB4 | 35 | Feedback input pin for SW4 |
| COMP4 | 36 | Compensation pin for external compensation network for SW4. Pulling this line high to VDDD configures the SW3 controller to control both SW3 and SW4. |
| SS4/PG4 | 37 | Soft-start for SW4 (default). A capacitor is used to set the startup time. This pin can also be reconfigured through I^2C to display the PGOOD4 signal instead |
| I2CADDR | 38 | Select I ² C address with resistor to AGND |
| RST_N | 39 | Reset of digital logic. When low, all switchers are disabled. Configuration is reloaded from EEPROM when RESET_N is deasserted. |
| RCLOCK_SYNC | 40 | Resistor for setting master clock frequency from 275 kHz to 2.2 MHz or for clock sync |



Pin Functions (continued)

| PIN | | DESCRIPTION |
|-------------|-----|---|
| NAME | NO. | DESCRIPTION |
| I2CALERT | 41 | Open-drain output that is pulled low for 200 μ s when a timeout condition is detected by the I ² C watchdog on either SDA or SCL. |
| SDA | 42 | Data input/output pin for I ² C bus |
| SCL | 43 | Clock input pin for I ² C bus |
| CLK_OUT | 44 | Clock output signal. Open-collector output, requires pull up. |
| SS1/PG1 | 45 | Soft-start for SW1 (default). A capacitor is used to set the startup time. This pin can also be reconfigured through I ² C to display the PGOOD1 signal instead. |
| COMP1 | 46 | Compensation pin for external compensation network for SW1 |
| VFB1 | 47 | Feedback input pin for SW1 |
| ENSW1/ENSEQ | 48 | Enable input pin for SW1. Active high. 2-µA internal pullup current is inside. |

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature (unless otherwise noted) ⁽¹⁾

| | | MIN | MAX | UNIT |
|---------------------|---|------|-------------|------|
| | PVIN1, PVIN2, PVIN3, PVIN4, VIN | -0.3 | 20 | |
| | CB1, CB2, CB3, CB4 referenced to SWx | -0.3 | 7.5 | |
| | ENSW1, ENSW2, ENSW3, ENSW4, SCL, SDA, CLK_OUT, VFB1, VFB2, VFB3, VFB4, RST_N, SCL, SDA, I2CALERT, CLK_OUT, I2CADDR, RCLOCK_SYNC | -0.3 | VDDD or 3.6 | |
| Input voltage | SW1, SW2, SW3, SW4 | -1 | 20 | V |
| vollago | VDDA, VDDG | -0.3 | 7.5 | |
| | PGOOD, SS1/PG1, SS2/PG2, SS3/PG3, SS4/PG4, COMP1, COMP2, COMP3, COMP4, CE | -0.3 | VDDA or 7.5 | |
| | VDDD | -0.3 | 3.6 | |
| T _{J(max)} | Junction temperature | | 150 | °C |
| | Maximum lead temperature (soldering, 10 s) | | 260 | °C |
| T _{stg} | Storage temperature | -65 | 150 | °C |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

| | | | | VALUE | UNIT |
|--------------------|----------------------------|---------------------------------|---|-------|------|
| | | Human-body model (HBM), per AEC | C Q100-002 ⁽¹⁾ | ±2000 | |
| V _(ESD) | Electrostatic discharge | Charged-device model (CDM), per | All pins | ±500 | V |
| | alconargo | AEC Q100-011 | Corner pins (1, 12, 13, 24, 25, 36, 37, and 48) | ±750 | |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | | MIN | MAX | UNIT |
|---------------------------------------|----------------------------|-----|------|------|
| VIN1, VIN2, VIN3, VIN4 | Input voltage range | 4.5 | 18 | V |
| I _{OUT1} , I _{OUT2} | Load current | 0 | 4 | А |
| I _{OUT3} , I _{OUT4} | Load current | 0 | 2 | А |
| $V_{FB1}, V_{FB2}, V_{FB3}, V_{FB4}$ | Voltage feedback | 0.6 | 1.87 | V |
| TJ | Junction temperature range | -40 | 125 | °C |

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NSTRUMENTS

Texas

7.4 Thermal Information

| | | TPS65400-Q1 | |
|-----------------------|--|-------------|------|
| | THERMAL METRIC ⁽¹⁾ | RGZ (VQFN) | UNIT |
| | | 48 PINS | |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance | 29.8 | °C/W |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 14.9 | °C/W |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 6.3 | °C/W |
| ΨJT | Junction-to-top characterization parameter | 0.2 | °C/W |
| Ψ _{JB} | Junction-to-board characterization parameter | 6.3 | °C/W |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | 0.8 | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

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7.5 Electrical Characteristics

 V_{IN} = 12 V, F_{SW} = 500 kHz, T_J = -40°C to 125°C, typical values are at T_J = 25°C, unless otherwise noted

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|---|------|-----------------------|------|------|
| SWITCHER 1 A | ND SWITCHER 2 | | | | | |
| limit1, I _{limit2} | SW1, SW2 high-side current limit adjustment range | | 2 | | 6 | А |
| limit-accuracy | Accuracy to nominal current limit value | I _{limit} = 4 A, 5 A, 6 A | -25% | | 25% | |
| Rdson HS | SW1, SW2 HS Rds(on) | | | 66 | | mΩ |
| Rdson LS | SW1, SW2 LS Rds(on) | | | 42 | | mΩ |
| SWITCHER 3 A | ND SWITCHER 4 | | | | | |
| _{limit3} , I _{limit4} | SW3 and SW4 current limit | | 0.5 | | 3 | Α |
| limit accuracy | Accuracy to nominal current limit value | I _{limit} = 1 A, 2 A, 3 A | -25% | | 25% | |
| Rdson HS | SW3 and SW4 HS Rds(on) | | | 120 | | mΩ |
| Rdson LS | SW3/4 LS Rds(on) | | | 90 | | mΩ |
| FEEDBACK AN | ID ERROR AMPLIFIERS FOR SW1 – SW | /4 | | | | |
| VFB | Accuracy | V _{REF} = 1 V | -1% | | 1% | |
| V _{REFn} | Error amplifier reference voltage | Default value | | 800 | | mV |
| V _{REF_STEP} | I ² C programmable V _{REF} step size | | | 10 | | mV |
| Gm | Error amplifier transconductance | | 95 | 133 | 165 | μS |
| sink | Sink | | | 12 | | μA |
| source | Source | | | 12 | | μA |
| РИМ SWITCHI | NG CHARACTERISTICS | | | | | |
| Phase_err12 ⁽¹⁾ | Phase error between SW1 and SW2 | F _{sw} = 1.1 MHz | | 5° | | |
| Phase_err34 ⁽¹⁾ | Phase error between SW3 and SW4 | $F_{sw} = 1.1 \text{ MHz}$ | | 5° | | |
| sw | Resistor-configurable PWM switching configuration | | 275 | | 2200 | kHz |
| F _{sw-accuracy} | PWM switching frequency accuracy | R_{OSC} = 165 kΩ (F _{sw} = 1.1 MHz) | -10% | | 10% | |
| V _{rclock_sync} | Voltage reference for RCLOCK_SYNC | | | 0.8 | | V |
| ON_min | Lower duty cycle limit | | | 80 | 150 | ns |
| OFF_min | Minimum off-time limit (constrains the maximum achievable duty cycle) | | | 150 | | ns |
| CLOCK SYNC | | | | | | |
| V_H _{SYNC} | High signal threshold | | 2.6 | | | V |
| V_L _{SYNC} | Low signal threshold | | | | 1 | V |
| CLKOUT | Max current sink/source for CLK_OUT | | | 2 | | mA |
| t _{min_SYNC} | Minimum detectable time for sync pulse | | | | 150 | ns |
| F _{SYNC} | Frequency synchronization range | | 275 | | 2200 | kHz |
| T _{SYNC_DELAY} | Delay between input pulse to RCLOCK_SYNC and rising edge of CLK_OUT and PWM output | | | 20 | | ns |
| TIMING CHAR | ACTERISTICS | ı I | | | | |
| t _{restart} | Delay for restart during repeated OCP condition | | | 20 | | ms |
| NTERNAL REG | GULATORS AND UVLO | | | | | |
| | | V _{in} > 6.6 V | | 6.1 | | |
| V _{DDA} | Internal subregulator output | 4.5 V < V _{in} 6.6 V | | V _{in} – 0.1 | | V |
| V _{DDD} | Output of internal subregulator | | | 3.2 | | V |
| | Output of Internal regulator for gate | V _{in} > 6.6 V | | 6.1 | | |
| V _{DDG} | drivers | 4.5 V < V _{in} 6.6 V | | V _{in} – 0.1 | | V |

(1) Specified by design.

Electrical Characteristics (continued)

 V_{IN} = 12 V, F_{SW} = 500 kHz, T_J = -40°C to 125°C, typical values are at T_J = 25°C, unless otherwise noted

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|--|------|------|------|------------------------|
| I _{VIN} | Quiescent non-switching, no load current | CE high, V _{FB} >> V _{REF} , (no switching) | | 8 | | mA |
| I _{SD} | Quiescent shutdown current | CE low | | 12 | 27 | μA |
| V _{IN_UVLO} | Input voltage UVLO | Rising | | 4.25 | 4.48 | V |
| V _{IN_UVLO} | Input voltage UVLO | Falling | 3.4 | 3.75 | | V |
| | Wx, RST_N, SSx, PG | | | | | |
| R_L _{PGOOD} | Resistance of PGOOD outputs when low | | | 500 | | Ω |
| V_OL _{PGOOD} | Logic output low voltage | I_OL = 100 μA | | | 0.1 | V |
| ss | Soft-start current | | 4.1 | 5.6 | 7.3 | μA |
| V _{EN_H} | Enable logic high threshold (for ENSW1, ENSW2, ENSW3, ENSW4) | V _{EN} rising | 1.12 | 1.20 | 1.28 | V |
| V _{EN_L} | Enable logic low threshold (for ENSW1, ENSW2, ENSW3, ENSW4) | V _{EN} falling | 0.97 | 1.07 | | V |
| V _{EN_HYS} | Enable hysteresis (for ENSW1, ENSW2, ENSW3, ENSW4) | | | 130 | | mV |
| I _{EN} | ENSWx pin pullup current | V _{EN} = 0 | | 2 | | μA |
| I _{CE} | CE pin pullup current | $V_{CE} = 0$ | | 2 | | μA |
| V _{IH_CE} | Logic input high for CE | | 1.3 | | | V |
| V _{IL_CE} | Logic input low CE | | | | 0.4 | V |
| V _{IH_RSTN} | Logic input high RST_N | | 1.3 | | | V |
| V _{IL_RSTN} | Logic input low RST_N | | | | 0.4 | V |
| I ² C MODULE (| SDA, SCL, I2CALERT, I2CADDR) | · · · · | | | | |
| V_IL _{I2C} | Logic input low SCL, SDA | | | | 0.8 | V |
| V_IH _{I2C} | Logic input high for SCL, SDA | | 2.1 | | | V |
| R_L _{I2C} | ON resistance of I ² C pins (SDA,SCL,I2CALERT) to GND | I2CALERT = 1 | | 85 | | Ω |
| V_OL _{I2C} | Logic output low voltage for SCL,SDA,I2CALERT pins | I_OL = 350 μA | | | 0.1 | V |
| I _{LEAK} | Input leakage current | SDA, SCL = 3.3 V | | | 1 | μA |
| I _{I2CADDR} | Source current of I2CADDR pin | VDDD = 3.3 V, VIN > 4.5 V | | 20 | | uA |
| t _{TIMEOUT} | Timeout detection on SDA or SCL low | | | 30 | | ms |
| t _{TIMEOUT_PULSE} | Duration of timeout pulse on I2CALERT | | | 200 | | μs |
| FAULTS | | | | | | |
| T _{TSD} ⁽²⁾ | Thermal shutdown threshold | | | 160 | | °C |
| T _{TSD_restart} ⁽²⁾ | Thermal shutdown hysteresis | | | 20 | | °C |
| | OVP threshold rising (fault latched, PGOOD asserted) | 0.6V < V _{REF} < 1.87 V | | 111 | | % c V _{RE} |
| V _{FB_OVP} | OVP threshold falling (fault cleared, PGOOD deasserted) | 0.6 V < V _{REF} < 1.87 V | | 104 | | % o V _{RE} |
| t _{ovpsdown} | Time after OVP before protection activation and PGOOD fall | | | 55 | 95 | μs |
| Versive | Undervoltage threshold (PGOOD deasserted) | 0.6 V < V _{REF} < 1.87 V | | 92 | | % o V _{RE} |
| V _{FB UVP} | Undervoltage Threshold (PGOOD asserted) | 0.6 V < V _{REF} < 1.87 V | | 83 | | % o V _{RE} |
| t _{UVPSDOWN} | Time after UVP before PGOOD fall | | | 55 | 95 | μs |

(2) Specified by lab validation.

7.6 System Characteristics

The following specification table entries are specified by the design (component values provided in the typical application circuit are used). These parameters are not specified by production testing. Minimum and Max values apply over the full operating ambient temperature range ($-40^{\circ}C \le T_{J} \le 125^{\circ}C$), over the V_{IN} range = 5 to 12 V, and I_{OUT} range unless otherwise specified. L = 3.3 µH, DCR = 10.4 m Ω , V_{OUT} = 1.2 V, 1% FB resistor.

| | PARAMETER | TEST CONDITIONS | MIN | ТҮР | MAX | UNIT |
|------------------------------|--|--|------|-----|-----|------|
| V _{LINEREG} | Line regulation | | | 0.1 | | %/V |
| V _{LOADREG} | Load regulation | | | 0.1 | | %/A |
| t _r | VOUT step duration (t _r) | For 50-mV step | | 30 | | μs |
| t _s | VOUT step settling time (t _s) | For 50-mV step | | 30 | | μs |
| V _{OVUV} | VOUT step overshoot/undershoot | For 50-mV step | | 6 | | mV |
| Efficiency (SW1 and SW2) | | Vin = 5 V, Vo = 1.2 V, lout = 4 A, $f_{sw} = 500 \text{ kHz}$ | | 77% | | |
| | | Vin = 12 V, Vo = 1.2 V lout = 4 A, $f_{sw} = 500 \text{ kHz}$ | | 76% | | |
| | | Vin = 5 V, Vo = 1.2 V, Iout = 2 A, f_{sw} = 500 kHz | | 77% | | |
| | Efficiency (SW3 and SW4) | Vin = 12 V, Vo = 1.2 V lout = 2 A, $f_{sw} = 500 \text{ kHz}$ | | 74% | | |
| IOUT _{match} | Average (⁽¹⁾) current sharing accuracy (SW1 and SW2, SW3 and SW4) | I _{load} = I _{OUTmax} | | 20% | | |
| IPK _{match} | Peak current (⁽²⁾) sharing accuracy (SW1 and SW2, SW3 and SW4) | I _{load} = I _{OUTmax} | | | 20% | |
| t _{acc} | Timing accuracy for delays and restarts | | -10% | | 10% | |
| t _{reset_delay} | Time after RSTn or CE is released for power sequence to begin | Default value | | 1 | | ms |
| t _{reset_delay_max} | Minimum delay after reset is released for power sequence to begin | t _{reset_delay} set to 0 ms | | | 1.1 | ms |

(1) Average current sharing accuracy is highly dependent on the matching of the inductor and capacitor.

(2) Peak current sharing accuracy refers to the max inductor current in each phase.

7.7 Operational Parameters

Values recommended that ensure proper system behavior

| | PARAMETER | MIN | TYP MAX | UNIT |
|----------------------------|---|-----|------------|------|
| C _A | Stabilization capacitor to be connected to VDDA | | 4.7 | μF |
| C _D | Stabilization capacitor to be connected to VDDD | 3.3 | | μF |
| C _G | Stabilization capacitor to be connected to VDDG | | 10 | μF |
| Vin1, Vin2, Vin3, Vin4 | SW1 to SW4 input voltage | 4.5 | 18 | V |
| Vout1, Vout2, Vout3, Vout4 | SW1 to SW4 output voltage | 0.6 | 90% of Vin | V |

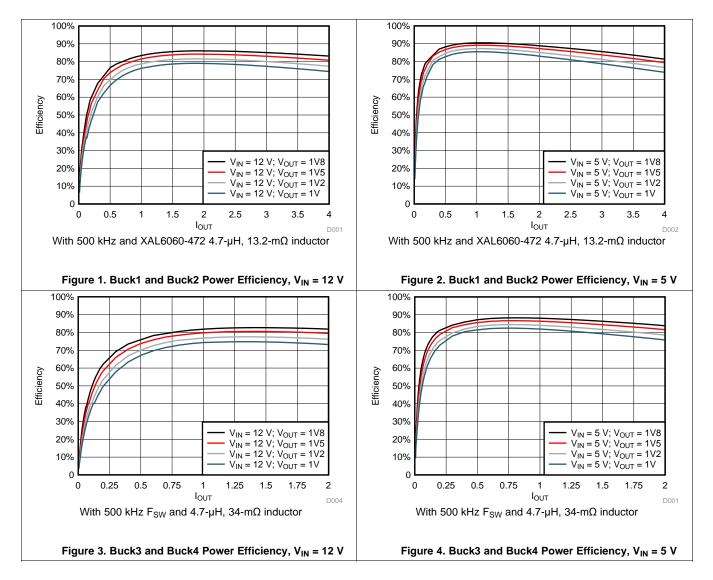
7.8 Package Dissipation Ratings⁽¹⁾

| PACKAGE | R _{θJA} (°C/W) | T _A = 25°C | T _A = 55°C | T _A = 85°C |
|---------|-------------------------|-----------------------|-----------------------|-----------------------|
| RGZ | 29.8 | 4.5 W | 3.14 W | 1.77 W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.



7.9 Typical Characteristics: System Efficiency





8 Detailed Description

8.1 Overview

The TPS65400-Q1 is an integrated PMU optimized for applications that require small form factor and high-power conversion efficiency enabling small space-constrained equipment with high-ambient operating temperature without cooling. It provides high-power efficiency at a system level by enabling a single-stage conversion from an intermediate distribution bus with an optimized combination of regulators.

The TPS65400-Q1 consists of four high-current buck-switching regulators (SW1, SW2, SW3, and SW4) with integrated FETs. The switching power supplies are intended for powering high-current digital circuits such as the processor, FPGA, ASIC, memory, and digital I/Os. SW1 and SW2 support 4 A each, and SW3 and SW4 support 2 A each. Each regulator's switching frequency is independently adjustable up to 2.2 MHz.

Current limit programmability on each switcher enables optimization of inductor ratings for a particular application configuration not requiring the maximum current capability.

The TPS65400-Q1 can be powered from a single-input voltage rail between 4.5 and 18 V, making it suitable for applications running off a 5- or 12-V intermediate power distribution bus.

Sequencing requirements can be met using the individual enable pins or by programming the sequence through the I^2C bus into the onboard EEPROM. Output voltages can be set through external resistor networks and VREF can be programmed from 0.6 to 1.87 V in 10-mV steps. All control and status info can be accessed through a PMBus-compatible I^2C bus.

The TPS65400-Q1 provides a high level of flexibility for monitoring and control through the I^2C bus while providing the option of programmability through the use of external components and voltage levels for systems not using I^2C .

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8.2 Functional Block Diagrams

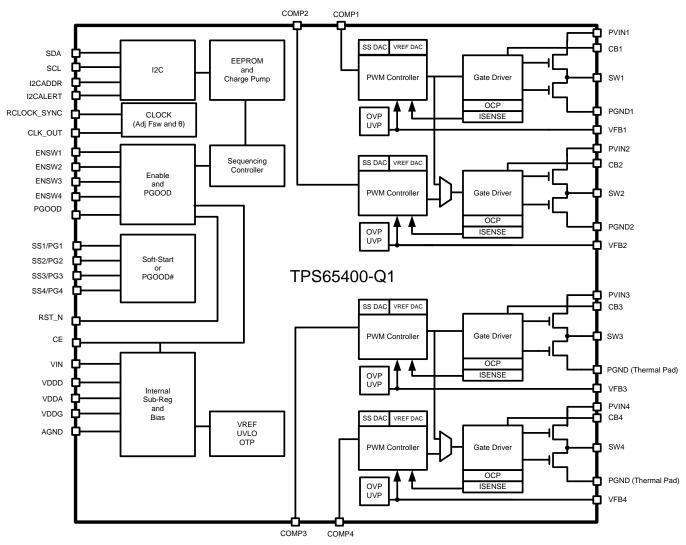
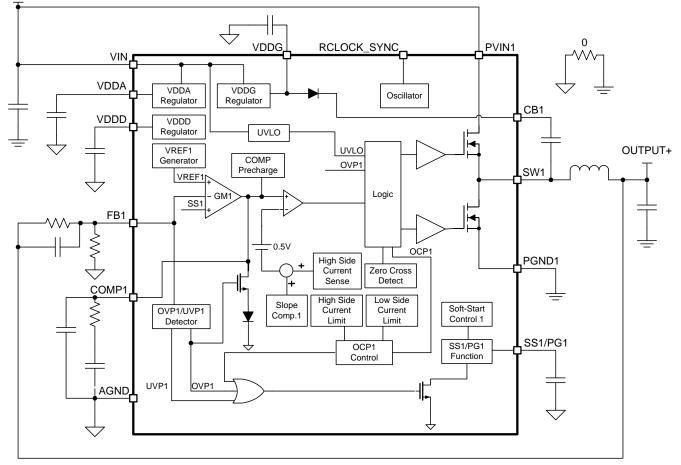


Figure 5. TPS65400-Q1 Functional Block Diagram



Functional Block Diagrams (continued)





A. All other switchers follow the same pattern

Figure 6. Simplified Control Block Diagram for Switcher1

8.3 Feature Description

8.3.1 Startup Timing and Power Sequencing

8.3.1.1 Startup Timing

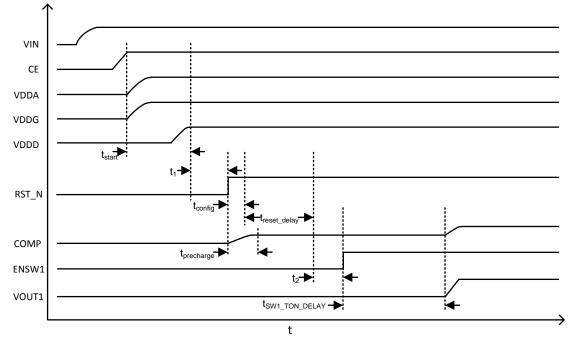
Figure 7 shows the startup timing of the TPS65400-Q1. Upon power-up or the rising edge of CE, the internal power rails VDDA, VDDG, and VDDD startup during the time labeled t_{start} . Following t_{start} , a delay of t_1 follows (which is defined by the user through the timing of RST_N). During time t_{start} and t_1 , the COMP terminal is internally discharged through a 1-k Ω resistor. At the rising edge of RST_N, the TPS65400-Q1 begins two actions:

- 1. The TPS65400-Q1 begins its precharge of the COMP terminal (indicated by t_{precharge}). The length of t_{precharge} needed to precharge the COMP terminal depends on the time constant of the R and C components. The internal precharge voltage source remains on even during normal operation, preventing the COMP terminal from falling below 0.6 V except during faults (OVP, OCP, and so forth).
- 2. The TPS65400-Q1 begins its configuration sequence (indicated by t_{config}), and loads parameters from the EEPROM. Parameters to be set include Vout, switching frequency, soft-start timing, and current limit.



Feature Description (continued)

After t_{config} is complete, t_{reset_delay} begins. The length of t_{reset_delay} is user-configurable through PMBus register DCh. After t_{reset_delay} is complete, the TPS65400-Q1 begins its startup sequence. The startup sequence is EEPROM-configurable, so any of the four switchers could be the first to startup with a configurable delay. In this particular example, SW1 is configured to startup first after a delay of $t_{SW1_TON_DELAY}$, which is configurable through PMBus register (DDh) TON_TOFF_DELAY.



A. PGOOD1 and ENSW2 are tied together externally, and t_{ON_DELAY1} and t_{ON_DELAY2} are configured through PMBus.

Figure 7. Timing Showing Startup from CE

To summarize, the length of time from rising edge of CE to soft-start of the first switcher in the sequence is:

 $t_{CE_{to}SS} = t_{start} + t_1 + t_{config} + t_{reset_{delay}} + t_2 + t_{SW1_{ON_{DELAY}}}$

(1)

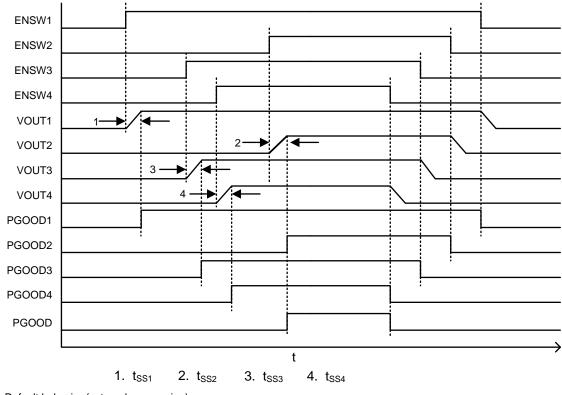
The delays, t_{reset_delay} and $t_{SW1_ON_DELAY}$, are both configurable through PMBus. The delay, t_{config} , is typically 1.1 ms. The delays, t_1 and t_2 , are determined by the user-defined timing of RST_N and ENSW1. They can both be set to 0 by pulling RST_N high before the end of t_{start} and ENSW1 high before the end of t_{reset_delay} . One simple way to do this would be to tie both signals to VDDD.

8.3.1.2 External Sequencing

To use external sequencing, either connect all the enable pins (ENSW1, ENSW2, ENSW3, and ENSW4) to an external sequencing controller, or connect them to PGOOD outputs as shown in Figure 8. By default, t_{ON_DELAY} and t_{OFF_DELAY} are both set to 5 ms. This allows the user complete flexibility of sequencing order and timing with the ENSWx pins without modifying any of the default settings in the TPS65400-Q1.



Feature Description (continued)



A. Default behavior (external sequencing)

Figure 8. Example of Sequencing Where Timing is Controlled by an External Sequencer With ENSWx Pins

8.3.1.3 Internal Sequencing

The default settings for SEQUENCE_ORDER (see *(D5h)* SEQUENCE_ORDER) effectively disable sequencing by setting all switchers to start at the same time. Therefore, to use internal sequencing, the default values for SEQUENCE_ORDER must be changed to the desired sequence. In addition, the user can configure the start or stop sequence to have a dependence on the PGOOD output of the previous switcher, or to wait for a set delay. If configured to have a dependence on PGOOD, the soft-start for the next switcher begins after PGOOD of the previous goes high and the wait time determined by t_{ON_DELAY} is complete. If configured to wait for a set delay, the wait time determined by t_{ON_DELAY} begins immediately upon the enabling of the previous switcher.

In addition, each supply can be disabled such that it is bypassed in the power-up sequence. For example, if the sequence is SW1-SW2-SW3-SW4, and SW2 is disabled, then SW3 will be powered up after SW1. The initial configuration of the TPS65400-Q1 (for first-time power-up) needs to be done using one of the methods described in *Initial Configuration*.

8.3.2 UVLO and Precision Enables

The TPS65400-Q1 implements a UVLO function that prevents startup when the voltage at VIN (terminal 22) is below 4 V. In most applications, VIN and all of the power rails (PVIN1, PVIN2, PVIN3, and PVIN4) are tied to the same source and this single UVLO function is sufficient. However, in some applications, the power rails may be tied to different input voltages, and there is the possibility that the TPS65400-Q1 may attempt to startup a switcher even when its associated PVINx rail has not reached a high-enough voltage. In these cases, the precision enable threshold on each ENSWx can be used to precisely set the startup threshold for each individual switcher with a simple resistor divider to PVINx.



Feature Description (continued)

In cases where a single UVLO threshold is needed for all four switchers, but at a different level than 4 V, the TPS65400-Q1 can be configured for single-terminal enable (PMBus register D2h, bits 0:1 = 10) where the ENSW1/ENSEQ terminal is used as a sequence enable terminal. Then, a resistor divider to the appropriate PVINx rail can be used to set a precise UVLO threshold that applies to all four switchers.

8.3.3 Soft-Start and Prebiased Startup

The TPS65400-Q1 implements a soft-start function that minimizes discharge of the output when starting up in a prebiased condition. Soft-start time, t_{SS} , is set by $t_{ON_TRANSITION_RATE}$ (digital soft-start) or by a capacitor connected to the corresponding SSx pin (analog soft-start). In this setup, the SSx pin sources a 5-µA current charging the capacitor, and the voltage at the SSx pin limits the reference voltage at the input of the error amplifier.

At the beginning of the soft-start, the soft-start input to the error amplifier is set to 0. The SSx input is raised gradually and reaches its target value during the time t_{ss} . If $V_{FB} > V_{SS}$, then no switching occurs. After the Soft-Start signal crosses VFB, the switching begins. The first switching pulse is on the low-side FET, which charges the high-side bootstrap capacitor. The unit runs in discontinuous conduction mode (DCM) with the zero-cross detector enabled on the low side (diode emulation). The high-side FET is pulsed according to the error amplifier output on the COMP pin. If the IC is configured for continuous conduction mode (CCM) operation (default), the low-side FET pulses gradually transition to normal CCM operation; at each successive switching cycle, the low-side gate pulse is gradually ramped until full synchronous switching occurs. At this point, the switcher enters normal CCM operation.

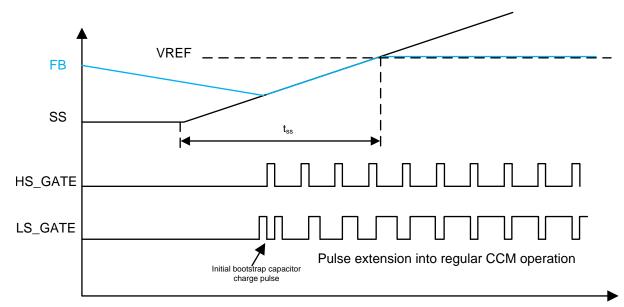


Figure 9. Soft-Start Under Prebiased Condition and CCM Mode Programmed



Feature Description (continued)

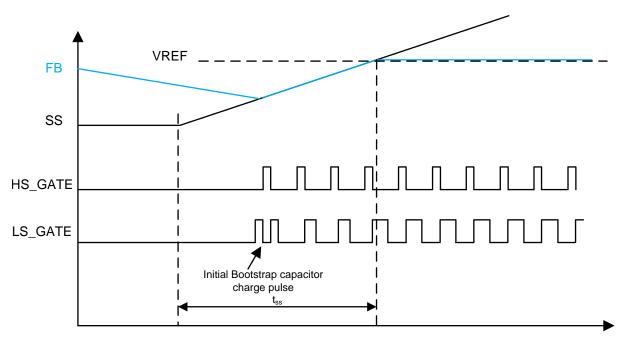


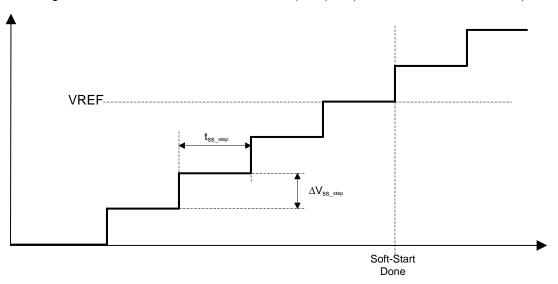
Figure 10. Soft-Start Under Prebiased Condition and DCM Mode Programmed

8.3.3.1 Analog Soft-Start (Default) and Digital Soft-Start

The TPS65400-Q1 has the ability to use an analog-based soft-start ramp based on external capacitors (one input for each switcher) or to use internal signals based on digital logics and DACs to perform the soft-start function.

When using external soft-start configuration (default configuration), the SSx pins are connected to the soft-start input of the error amplifier.

When using the internal digital soft-start signal, the soft-start input to the error amplifier increases step-by-step at a rate set according to the value set in TON_RAMP_RATE (see (DEh) TON_TRANSITION_RATE).





 $\Delta VSS_$ step is 10 mV. Tss_step depends on the soft-start time option selected. See (*DEh*) TON_TRANSITION_RATE for more details.

(3)

Feature Description (continued)

8.3.3.2 Soft-Start Capacitor Selection

When using external soft-start capacitor to set the soft-start time, use Equation 2.

$$t_{ss} = \frac{Css}{lss} \times Vref$$
 (2)

Css is the value of the capacitor connected between the SSx pin and AGND. VREF is the value of the reference voltage (default is 0.8 V). I_{SS} is the current sourced by the SS1/PG1 pin during soft-start.

8.3.4 PWM Switching Frequency Selection

The master clock frequency, F_{OSC} , can be set by external resistor on the RCLOCK_SYNC terminal, or by synchronizing with an external clock. To set using an external resistor, use this formula.

 F_{SW} (kHz) = 138664 R_{OSC} (k Ω)^{-0.948}

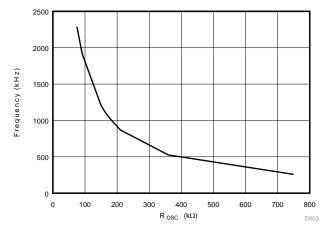


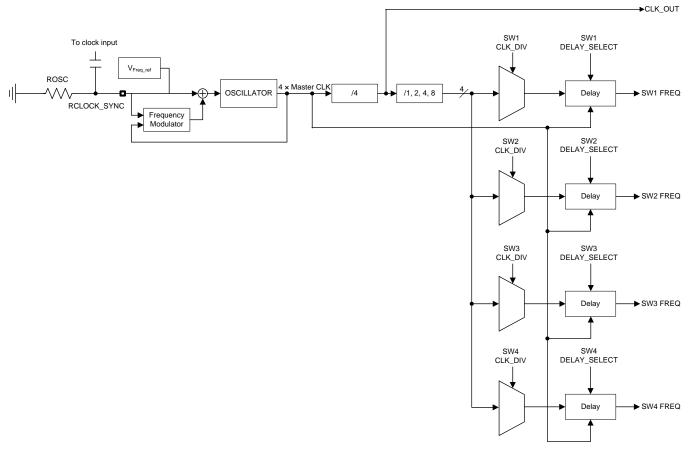
Figure 12. Frequency vs R_{osc}

To sync to an external source, an AC-coupled signal should be applied to the terminal. A fixed resistor should still be connected to set a minimum frequency. The frequency of the input signal to synchronize with should always be higher than the minimum frequency. If the internal PLL cannot synchronize, the switchers will fall back to the minimum frequency set by the resistor. The CLK_OUT terminal outputs the master clock F_{OSC}.

The PWM frequency of each switcher is determined by this master clock frequency and an I²C-programmable choice of 4 divider ratios (1, 2, 4, or 8) by setting CLK_DIV (see *(D7h) FREQUENCY_PHASE*).



Feature Description (continued)



A. The frequency modulator is used for external clock synchronization.

Figure 13. Diagram of PWM Clock Generation

The intent of the individual divider ratios is to allow users to set the frequency of each switcher independently. For example, with a master clock F_{OSC} of 1.1 MHz, SW1 and SW2 have a divider ratio of 4 for a 275-kHz PWM, and SW3 and SW4 have a divider ratio of 1 for a PWM frequency of 1.1 MHz. Select the divider ratio so that the PWM frequency stays within the range of 275 kHz to 2.2 MHz for whichever master clock frequency is set.

In addition to selecting the frequency, each switcher can have its PWM frequency delayed. This enables the designer to minimize ripple current by properly selecting the delays so that the switching frequencies are out of phase. The default switching frequency is at CLK_DIV = F_{OSC} / 1 with PHASE_DELAY for SW1 at 0°, SW2 at 180°, SW3 at 90°, and SW4 at 270°. More information on frequency selection and delay is given in (D7h) FREQUENCY_PHASE.

8.3.5 Clock Synchronization

The RCLOCK_SYNC terminal can be used to synchronize the master clock switching frequency, F_{OSC} , with an external clock source or another TPS65400-Q1. The external clock signal (which can come from another TPS65400-Q1 CLK_OUT terminal) should be AC coupled to the RCLOCK_SYNC terminal as shown in Figure 14. Choose the ROSC value so that the fixed frequency is nominally 30% lower than the external synchronizing clock frequency. An internal protection diode clamps the low level of the synchronizing signal to approximately -0.5 V. The internal clock synchronizes to the rising edge of the external clock.

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Feature Description (continued)

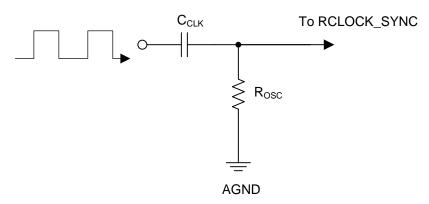


Figure 14. AC-Coupled Clock Synchronization

TI recommends to choose an AC-coupling capacitance in the range of 50 to 100 pF. Exceeding the recommended capacitance may inject excessive energy through the internal clamping diode structure present on the RCLOCK_SYNC terminal. The typical trip level of the synchronization terminal is 1.5 V. To ensure proper synchronization and to avoid damaging the IC, the peak-to-peak value (amplitude) should be between 2.5 V and V_{DDA} . The minimum duration of this pulse must be greater than 200 ns, and its maximum duration must be 200 ns less than the period of the switching cycle.

The external clock synchronization process begins after the TPS65400-Q1 is enabled and an external clock signal is detected. The frequency modulator adjusts the oscillator frequency to match the frequency of the pulses into the RCLOCK_SYNC terminal. It generally takes 50 cycles before the PWM frequency locks. If the external clock signal is removed after frequency synchronization, the master clock F_{OSC} drifts to the frequency selected by ROSC.

8.3.6 Phase Interleaving

The TPS65400-Q1 offers the ability to output rails of higher currents by connecting SW1 and SW2 in parallel, or by connecting SW3 and SW4 in parallel. To configure this option, the COMP2 or COMP4 terminal must be tied to VDDA through a $4-k\Omega$ resistor.

Upon the initialization sequence after a reset, the TPS65400-Q1 attempts to discharge the COMP terminal through a 2-k Ω internal resistor. When it detects that the COMP terminal is pulled high, it configures itself to operate in current sharing mode. If SW2 is set to current sharing mode, its PWM output is controlled by the error amplifier and COMP1 terminal of SW1 and set to the same frequency as SW1. Likewise, if SW4 is set to current sharing mode, its PWM output is controlled by the error amplifier and COMP3 terminal of SW3 and set to the same frequency as SW3. This means that the frequency settings for SW2 and SW4 in the EEPROM are ignored in that mode of operation.

When current sharing mode is detected on a particular pair, the output slave's l²C access is invalid and the output slave's default settings follow that of its master (see *(00h) PAGE*). The only exception is that the slave switcher PWM is a fixed 180° phase-shift from its master.

| Pair | Output | Current Sharing Relationship | Switching Frequency | Switching Phase |
|---------|--------|------------------------------|---------------------|-----------------|
| SW1-SW2 | SW1 | Master | Programmable | Programmable |
| | SW2 | Slave | Follows master | Master + 180° |
| SW3-SW4 | SW3 | Master | Programmable | Programmable |
| | SW4 | Slave | Follows master | Master + 180° |

 Table 1. Programmable Options When Current Sharing Enabled



8.3.7 Fault Handling

OVP, OCP, and undervoltage protection (UVP) are handled for each switcher independently. OVP or OCP faults that occur on one switcher do not affect the other outputs. There are two exceptions:

- If current-sharing mode (ISHARE) is detected for a switcher that faults, both switchers in parallel have the same response to OVP or OCP.
- When using internal sequencing, in the case of faults occurring during the initial power-up sequence, all switchers are disabled for 500 ms, after which, the startup sequence is restarted.

During the soft-start time for a switcher, all fault signals (OVP, OCP, and UVP) are disabled and reset to the unfaulted condition. The first moment when faults can be triggered is after the end of the soft-start sequence.

OVP thresholds are set as a percentage of VREF. A deglitching time of 50 µs is used for the overvoltage. When an overvoltage occurs at the OVP upper threshold limit, the high-side FET and the low-side FET are disabled for that switcher until the OVP falling threshold is reached. When the OVP falling threshold is reached, the low-side FET turns on for 200 ns to ensure that the bootstrap capacitor is recharged before resuming normal operation of the converter.

Output voltage falling below the UVP thresholds causes the corresponding PGOOD output to fall, but the switcher continues to operate as it tries to increase the output voltage. However, if the PGOOD terminal is tied to the enable ENSWx signal of another switcher on the PCB (for external sequencing), the output for that ENSWx-PGOOD-tied switcher is disabled until output voltage is nominal and PGOOD is good.

OTP shuts down all switchers. When the temperature drops below the hysteresis level, a soft reset is triggered and the chip restarts from the startup sequence.

Fault Monitoring describes fault reporting and clearing of fault status registers.

The OVP and UVP sensing is deglitched to prevent unwanted tripping. The faults need to be sustained for more than 55 µs typically (60 µs max) to be registered and trigger protection circuits and PGOOD output to fall. Fault detection is disabled on a given switcher when its VREF is being ramped (as result of an I²C command to change VREF). An additional 100-µs fault blanking time results after VREF has been adjusted to its target level.

8.3.8 OCP for SW1 to SW4

The OCP is I²C-programmable and set by the IOUT_MAX command. By default, the peak current IOUT_MAX for SW1 and SW2 is 6 A, and for SW3 and SW4 it is 3 A. When the current reaches this threshold, the unit immediately turns off the high-side FET and keeps the low-side FET off for the remainder of the switching cycle. The following cycle are skipped (high-side FET off, low-side FET off) regardless of the inductor current. If the current in the inductor is still higher than the IOUT_MAX after the skipped cycle, the following cycles are also skipped until the current reach below the IOUT_MAX.

If the IOUT_MAX is reached more than 256 active cycles continuously, the switcher shut downs for 20 ms and restarts. If the switcher is running in interleaved operation, both the switcher that tripped the IOUT_MAX threshold and its interleaved counterpart shut down for 20 ms. After that period of time, the unit restarts and goes through soft-start operation. For very-low duty cycle operation and faulty operation with very-fast current increase during the high-side FET on-time (due to inductor saturation and so forth), OCP is also enforced on the low side to ensure no runaway condition exists.

| opnono | | | | | |
|-------------|---------------|--|--|--|--|
| SWITCHER | IOUT_MAX | | | | |
| | 2 A | | | | |
| SW1, SW2 | 3 A | | | | |
| | 4 A | | | | |
| | 5 A | | | | |
| | 6 A (default) | | | | |
| | 0.5 A | | | | |
| C10/2 C10/4 | 1 A | | | | |
| SW3, SW4 | 2 A | | | | |
| | 3 A (default) | | | | |
| | | | | | |

Table 2. Current Limit Options

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While the converter is shut down following an OCP event spanning more than 256 cycles, the COMP terminal is pulled low for 1.1 ms prior to precharge and re-enabling of the converter. At the same time, the SSx pin is discharged to AGND for 1.1 ms. If the soft-start is digital (SSx pins used as PGOODx outputs), the soft-start value is reset.

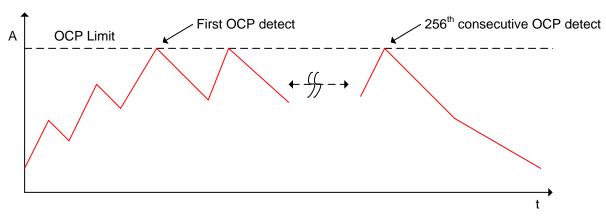
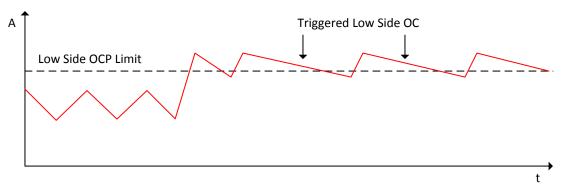


Figure 15. Inductor Current During Overcurrent Event

At high switching frequency (>1 MHz) and particularly when there is a fault in the converter such as saturation of the inductor, the current sensor might not sense the overcurrent event. To ensure that current protection is provided in all operating scenarios, low-side current sensing is also present to provide overcurrent detection and protection when the low-side FET is on. If over-current is detected when the low-side FET is on, the low-side FET stays on (and the high-side FET off) until the current drops below the threshold. A new cycle will then begin (high side on, low side off) when the next switching cycle occurs as driven by the internal clock derived from the oscillator (internal or external synchronization). A dedicated counter records the low-side OCP events and initiates a shutdown of the converter after 256 OCP event counts. Six consecutive cycles without a low-side OCP event resets the counter.





8.3.9 Overcurrent Protection for SW1 to SW4 in Current Sharing Operation

When the converter is running in interleaved operation, an OCP event will not trigger the COMP terminal to be pulled low to 0.6 V. Instead, the error amplifier is switched off (tri-stated). This ensures that the COMP terminal voltage remains constant so that the other phase continues to operate during the OCP event. An OCP event on one switcher lasting more than 256 cycles triggers the shutdown of both switchers running in interleaved mode.

8.3.10 Recovery on Power Loss

All contents of the registers are saved and stored in the data store (non-volatile memory) with the exceptions listed in Table 4 (Supported PMBus Commands) when STORE_DEFAULT_ALL is issued. Contents of the registers are copied from the data store when power is restored. This allows the system processor to turn on the power supplies as needed with the same default settings before power was lost.



8.3.11 Feedback Compensation

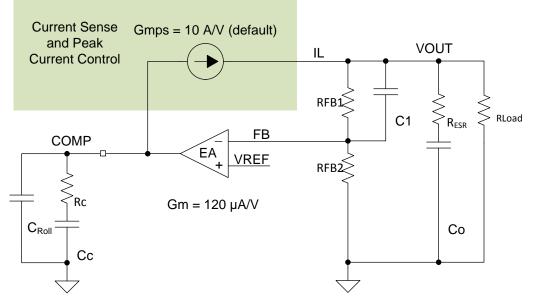


Figure 17. Simplified Equivalent Feedback Compensation Network

A typical compensation circuit could be type II (R_c and C_c) to have a phase margin between 60° and 90°, or type III (R_c , C_c , and C_{ff}) to improve the converter transient response. C_{Roll} adds a high-frequency pole to attenuate high-frequency noise when needed. C_{Roll} should be set to at least twice the crossover frequency to avoid interacting with the feedback compensation. It may also prevent noise coupling from other rails if there is possibility of cross coupling in between rails when layout is very compact.

Table 3 shows the recommended values for the compensation network components as an initial start. These result in the compensating zero of the Type II to match the dominant pole of the converter.

| | TYPE II | TYPE III |
|---|---|--|
| Select cross over frequency to be less than 1/5 of switching frequency (typical is 1/10) | $F_{C} = \frac{F_{SW}}{10}$ | $F_{C} = \frac{F_{SW}}{10}$ |
| Set R _C | $R_{C} = \frac{2\pi \times F_{C} \times V_{OUT} \times C_{O}}{Gm \times Gm_{PS} \times VREF}$ | $R_{C} = \frac{2\pi \times F_{C} \times C_{O}}{Gm \times Gm_{PS}}$ |
| Set C _C | $C_{C} = \frac{R_{LOAD} \times C_{O}}{R_{C}}$ | $C_{C} = \frac{R_{LOAD} \times C_{O}}{R_{C}}$ |
| Add C_{Roll} if needed to remove large signal coupling to high impedance COMP node. | $C_{Roll} = \frac{R_{esr} \times C_o}{R_C}$ | $C_{Roll} = \frac{R_{esr} \times C_o}{R_C}$ |
| $C_{\rm ff}$ compensating capacitor for type III compensation network. Choose $fz_{\rm ff}$ same as $F_{\rm C}$. | N/A | $C_{ff} = \frac{1}{2\pi \times fz_{ff} \times R_{FB1}}$ |

Table 3. Compensation Calculation Table

The output voltage of each buck is set with a resistor divider from BUCK output to FB pin and ground. TI recommends to use a 1% tolerance resistor or better one to get higher output voltage accuracy.



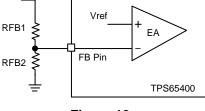


Figure 18.

With RFB1 and RFB2, output voltage is determined by:

Vout = Vref
$$\times \left(1 + \frac{\text{RFB1}}{\text{RFB2}}\right)$$

Default Vref in TPS65400-Q1 is 0.8 V. It can be programed from 0.6 to 1.87 V by digital interface PMBus. See *(D8h)* VREF_COMMAND for more detailed information.

8.3.13 Digital Interface – PMBus

TPS65400-Q1 implements a PMBus-compatible I²C digital interface. The PMBus specification referenced by this section is *PMBus Power System Management Protocol Specification Part I – General Requirements, Transport and Electrical Interface*, Revision 1.2, dated 6 September 2010. The specification is published by the Power Management Bus Implementers Forum and is available from http://pmbus.org/Specifications. See details in *PMBus* and *Register Maps*.

8.3.14 Initial Configuration

The recommended method of configuring the TPS65400-Q1 the first time is through an external programmer through a separate I²C programming header (as shown in Figure 19). The programming header needs to connect to the SCL, SDA, CE, VDDD, and DGND lines, and can be done using a USB-to-I²C tool. This enables the user to tailor the settings of the TPS65400-Q1 for each PCB specifically after PCB assembly, before the first power-up of the board.

An alternative method is to use the firmware in an on-board microcontroller to do the initial configuration. To do this, the user has two options:

- Power the microcontroller and the TPS65400-Q1 (VDDD, CE, and DGND connections needed) from an external source not controlled by the TPS65400-Q1.
- Design the PCB so that the default settings of the TPS65400-Q1 allow the microcontroller to be powered when power is applied to the TPS65400-Q1 the first time. The designer also needs to ensure that the default power-up sequence, ramp-rates, and other default parameters do not damage any components when power is applied the first time. After configuration, the microcontroller should pull CE low, and then all future powerups result in the newly configured power-up scheme to occur.

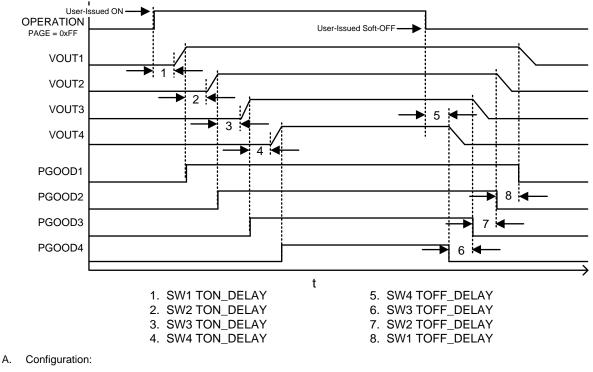
Using either method for the microcontroller requires the firmware to check if the TPS65400-Q1 has been previously configured, or if a modification needs to be made to an already programmed configuration. Users may use USER_DATA_BYTE_00 and/or USER_DATA_BYTE_01 to store a version number to identify which version of the configuration is stored in the TPS65400-Q1.

A hybrid option may also be done where the initial configuration is done using an external programmer, and the subsequent revisions are done through the microcontroller firmware. This eliminates the risk from damage caused by the default configuration during the first power-up, but still allows the microcontroller firmware to modify settings such as the VREF settings for subsequent power-ups.



(4)





- 1. Enable pins ENSWx set to inactive in PIN_CONFIG_00
- 2. Start sequence order SW1-SW2-SW3-SW4 in SEQUENCE_ORDER
- 3. Stop sequence order SW4-SW3-SW2-SW1 in SEQUENCE_ORDER

Figure 19. Example of Internal On Sequencing and Off Sequencing With the Default START_PGOOD Dependence

OPERATION (SWx) refers to OPERATION register in the corresponding PMBus PAGE. See (01h) OPERATION for more information on the OPERATION register.



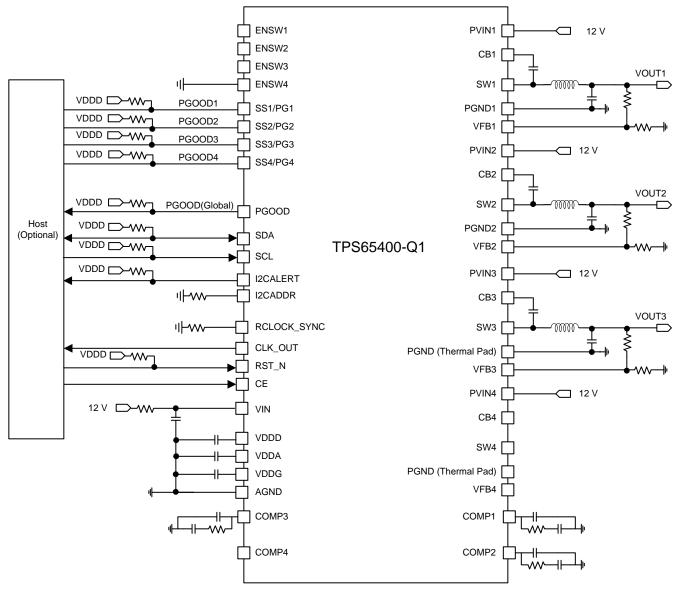


Figure 20. Internal Sequencing Schematic With Host



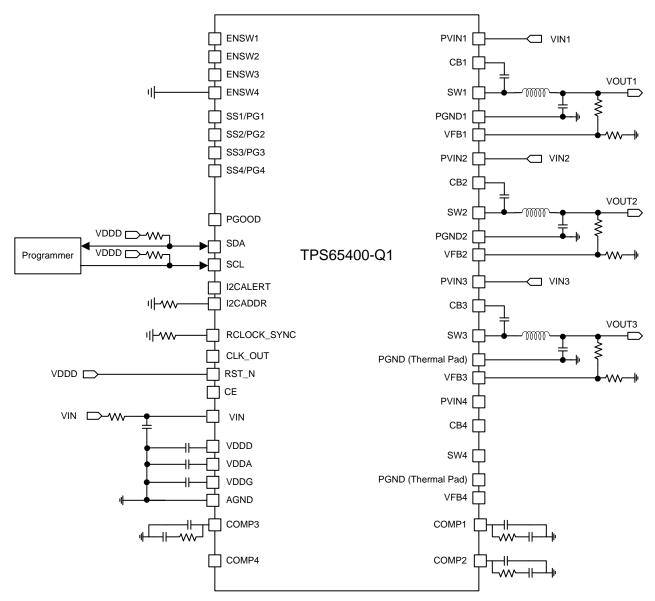


Figure 21. Internal Sequencing Schematic Without Host

8.4 Device Functional Modes

8.4.1 CCM Operation Mode

When the VIN/PVINx are above UVLO threshold and ENSWx are above the threshold, all four switchers operate in continuous current mode(CCM) with IOUT_MODE(see (*D6h*) *IOUT_MODE*) setting default. In CCM, the converters work in peak current mode for easy loop compensation and cycle-by-cycle high side MOSFET current limit.

8.4.2 CCM/DCM Operation Mode

When DCM mode is enabled by setting IOUT_MODE (see *(D6h) IOUT_MODE*), the switchers transition to DCM operation at light loads. During DCM mode, the low-side FET is turned off to prevent negative inductor current. This increases light-load efficiency, but output ripple and transient response during DCM or during transitions between DCM and CCM mode can be degraded.



Device Functional Modes (continued)

At light load, the COMP terminal is driven by the error amplifier to the minimum clamp voltage. When the COMP voltage reaches below 0.6 V and the error amplifier is sinking more than 5 μ A, both the high-side and low-side FET will be tri-stated to prevent the output voltage from rising above the set value. The FET function is reenabled when the GM amplifier sinks less than 3 μ A. This results in a burst mode operation at light load. The low-side FET has a 200-ns one-shot ON-time to ensure that the bootstrap capacitor is charged before the normal function of the converter is resumed.

8.4.3 Current Sharing Mode

When SW1/SW2 pair output and/or SW3/SW4 pair output are shared, the responding pairs current sharing mode is enabled and the ENABLE_PIN_CONFIG is set to single ENABLE. For the detail configuration, see *Current Sharing Typical Application*.



8.5 Register Maps

Table 4 lists the PMBus commands. Commands 00h through CFh are defined in the *PMBus Specification* and are considered to be core commands that are standardized for all manufacturers and products. Commands D0h through FEh are manufacturer-specific and may be unique for each manufacturer and product. Commands that are not supported by the device are not listed.

| Code | Name | SMBUS Transaction Type: Writing Data | SMBUS Transaction Type: Reading Data | Data Bytes | PAGE Support | Saved to Data Flash | Description |
|------|-------------------------|---|---|------------|--------------|------------------------|--|
| 00h | PAGE | Write byte | Read byte | 1 | _ | No | Selects output rail (see (00h) PAGE) |
| 01h | OPERATION | Write byte | Read byte | 1 | 00-03, FF | No | Starts or stops output (see (01h) OPERATION) |
| 03h | CLEAR_FAULTS | Send byte | _ | 0 | 00-03, FF | _ | Clears all faults (see (03h) CLEAR_FAULTS) |
| 10h | WRITE_PROTECT | Write byte | Read byte | 1 | _ | No | Used to lock bus writes (see (10h) WRITE_PROTECT) |
| 11h | STORE_DEFAULT_ALL | Send byte | _ | 0 | | _ | Stores operating memory to default store (see (11h) STORE_DEFAULT_ALL) |
| 19h | CAPABILITY | _ | Read byte | 1 | _ | _ | Describes PMBUS capabilities (see (19h) CAPABILITY) |
| 78h | STATUS_BYTE | — | Read byte | 1 | 00-03, FF | _ | Fault register (see (78h) STATUS_BYTE) |
| 79h | STATUS_WORD | _ | Read word | 2 | 00-03, FF | _ | Fault register (see (79h) STATUS_WORD) |
| 7Ah | STATUS_VOUT | _ | Read byte | 1 | 00-03, FF | _ | Output fault register (see (7Ah) STATUS_VOUT) |
| 80h | STATUS_MFR_SPECIFI C | _ | Read byte | 1 | _ | _ | Status register (PGOOD#_N) (see (80h) STATUS_MFR_SPECIFIC) |
| 98h | PMBUS_REVISION | _ | Read byte | 1 | _ | _ | PMBUS revision support (see (98h) PMBUS_REVISION) |
| ADh | IC_DEVICE_ID | _ | Read block | 7 | _ | _ | IC part number in ASCII (see (ADh) IC_DEVICE_ID) |
| AEh | IC_DEVICE_REV | _ | Read block | 2 | _ | _ | IC part revision code (see (AEh) IC_DEVICE_REV) |
| D0h | USER_DATA_BYTE_00 | Write byte | Read byte | 1 | _ | Yes | User-defined data (see (D0h) USER_DATA_BYTE_00) |
| D1h | USER_DATA_BYTE_01 | Write byte | Read byte | 1 | _ | Yes | User-defined data (see (D1h) USER_DATA_BYTE_01) |
| D2h | PIN_CONFIG_00 | Write byte | Read byte | 1 | _ | Yes | Configures pin behavior (see (D2h) PIN_CONFIG_00) |

| Table 4. Suppo | rted PMBus | Commands |
|----------------|------------|----------|
|----------------|------------|----------|

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| Register | Maps | (continued) |
|----------|------|-------------|
| regiotor | mapo | |

| | Table 4. Supported PMBus Commands (continued) | | | | | | | |
|--|---|-----------|---|-------|-----|--|--|--|
| SMBUS Transaction Type: Writing Data SMBUS Transaction Type: Reading Data Data Bytes PAGE Support Saved to Da Flash | | | | | | | | |
| | Write byte | Read byte | 1 | 00-03 | Yes | | | |

| Code | Name | SMBUS Transaction Type: Writing Data | SMBUS Transaction Type: Reading Data | Data Bytes | PAGE Support | Saved to Data Flash | Description |
|---------|--------------------------|---|---|------------|--------------|------------------------|--|
| D3h | PIN_CONFIG_01 | Write byte | Read byte | 1 | 00-03 | Yes | Configures rail-specific pin behavior (see (D3h) PIN_CONFIG_01) |
| D4h | SEQUENCE_CONFIG | Write byte | Read byte | 1 | _ | Yes | Configures sequence behavior (see (D4h) SEQUENCE_CONFIG) |
| D5h | SEQUENCE_ORDER | Write byte | Read byte | 1 | 00-03 | Yes | Configures sequence order (see (D5h) SEQUENCE_ORDER) |
| D6h | IOUT_MODE | Write byte | Read byte | 1 | 00-03 | Yes | Sets CCM / DCM, current sharing status (see (<i>D6h</i>) <i>IOUT_MODE</i>) |
| D7h | FREQUENCY_PHASE | Write byte | Read byte | 1 | 00-03 | Yes | Sets switcher frequency and phase (see (<i>D7h</i>) FREQUENCY_PHASE) |
| D8h | VREF_COMMAND | Write byte | Read byte | 1 | 00-03 | Yes | Sets reference voltage (V _{REF}) (see (D8h) VREF_COMMAND) |
| D9h | IOUT_MAX | Write byte | Read byte | 1 | 00-03 | Yes | Sets current limit (see (D9h) IOUT_MAX) |
| DAh | USER_RAM_00 | Write byte | Read byte | 1 | _ | No | RESET notification (see (DAh) USER_RAM_00) |
| DBh | SOFT_RESET | Send byte | — | 0 | _ | _ | Soft resets device (see (DBh) SOFT_RESET) |
| DCh | RESET_DELAY | Write byte | Read byte | 1 | _ | Yes | Sets delay after reset (see (DCh) RESET_DELAY) |
| DDh | TON_TOFF_DELAY | Write byte | Read byte | 1 | 00-03 | Yes | Sets delay before output begins to turn ON/OFF (see (DDh) TON_TOFF_DELAY) |
| DEh | TON_TRANSITION_RAT E | Write byte | Read byte | 1 | 00-03 | Yes | Sets soft-start time (see (DEh) TON_TRANSITION_RATE) |
| DFh | VREF_TRANSITION_RA TE | Write byte | Read byte | 1 | 00-03 | Yes | Sets ramping parameters for real- time Vref settings in output (see (DFh) VREF_TRANSITION_RATE) |
| E0h-EFh | — | — | — | _ | — | — | Reserved |
| F0h | SLOPE_COMPENSATIO N | Write byte | Read byte | 1 | 00-03 | Yes | Adjusts control loop compensation (see (F0h) SLOPE_COMPENSATION) |
| F1h | ISENSE_GAIN | Write byte | Read byte | 1 | 00-03 | Yes | Adjusts control loop current sense (see (F1h) ISENSE_GAIN) |

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Register Maps (continued)

Table 4. Supported PMBus Commands (continued)

| Code | Name | SMBUS Transaction Type: Writing Data | SMBUS Transaction Type: Reading Data | Data Bytes | PAGE Support | Saved to Data Flash | Description |
|------|-------------|---|---|------------|--------------|------------------------|--|
| FCh | DEVICE_CODE | _ | Read word | 2 | _ | _ | IC part revision code (see (FCh) DEVICE_CODE) |

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Table 5. Command Bit-Mapping

| | | | | | | | В | its | | | |
|------|-----------------------------|---------------|------|---------------|-------|--------------|---------------|-------------------|-------------------|-------------------|----------------------|
| Code | Name | Default Value | Byte | 7 (MSB) | 6 | 5 | 4 | 3 | 2 | 1 | 0 (LSB) |
| 00h | PAGE | 0xFF | 0 | · | | | PA | GE | | | |
| 01h | OPERATIO N | 0x80 | 0 | | OF | PERATION | | x | x | x | x |
| 03h | CLEAR_FA ULTS | | | | | | - | _ | | | |
| 10h | WRITE_PR OTECT | 0x40 | 0 | WRITE_PROTECT | | | | | | | |
| 11h | STORE_DE FAULT_ALL | | | _ | | | | | | | |
| 19h | CAPABILIT Y | 0xA0 | 0 | PEC | | BUS | SMB_ALER T | x | x | x | x |
| 78h | STATUS_B YTE | 0b0XXXX0XX | 0 | x | OFF | VOUT_OV | IOUT_OC | TEMPERAT URE | x | CML | NONE OF THE ABOVE |
| 70h | STATUS_W | 0b0XXXX0XX | 0 | x | OFF | VOUT_OV | IOUT_OC | TEMPERAT URE | x | CML | NONE OF THE ABOVE |
| 790 | 79h ORD | 0bX00XX000 | 1 | VOUT | х | x | MFR | POWER_G OOD_N | x | x | x |
| 7Ah | STATUS_V OUT | 0bX00X0000 | 0 | VOUT_OV | х | x | VOUT_UV | x | x | x | x |
| 80h | STATUS_M FR_SPECIF IC | 0b0000XXXX | 1 | x | x | x | x | POWER_G OOD4_N | POWER_G OOD3_N | POWER_G OOD2_N | POWER_G OOD1_N |
| 98h | PMBUS_RE VISION | 0x22 | 0 | | Par | t I Revision | | | Part II F | Revision | |
| | | 0x07 | 0 | | | | Ler | ngth | | | |
| | | 0x4C | 1 | | | | ٤ | Ľ' | | | |
| | | 0x4D | 2 | | | | ľ | M' | | | |
| | IC_DEVICE | 0x32 | 3 | | | | ٤. | 2' | | | |
| ADh | _ID | 0x36 | 4 | | | | ŝ | 6' | | | |
| | | 0x34 | 5 | | | | " | 4' | | | |
| | | 0x33 | 6 | | | | (. | 3' | | | |
| | | 0x30 | 7 | | | | ٤ | 0' | | | |
| | | 0x02 | 0 | | | | Ler | ngth | | | |
| AEh | IC_DEVICE _REV | 0xFX | 1 | | DEVIC | CE_CODE_ID | | | DEVICE_C | CODE_REV | |
| | _KEV _ | 0x00 | 2 | | | | DEVICE | CODE_ID | | | |
| D0h | USER_DAT A_BYTE_00 | 0x00 | 0 | | | | | A_BYTE_00 | | | |



| 0.1 | Nama | Default Value | | Dute | | | | В | its | | | | |
|------|-----------------------------|---------------|-----------|------|---------|-------------------|---|------------|------------|----------|-------------------|---------------------|--|
| Code | Name | Defau | lit value | Byte | 7 (MSB) | 6 | 5 | 4 | 3 | 2 | 1 | 0 (LSB) | |
| D1h | USER_DAT A_BYTE_01 | C |)x00 | 0 | | USER_DATA_BYTE_01 | | | | | | | |
| D2h | PIN_CONFI G_00 | 0 | x3C | 0 | x | PGOOD_PIN_CONFIG | | | | | ENABLE_PIN_CONFIG | | |
| D3h | PIN_CONFI G_01 | 0x00 | | 0 | x | x | x | x | x | x | x | SSPG_PIN_ CONFIG | |
| D4h | SEQUENCE _CONFIG | 0x00 | | 0 | x | x | х | x | x | x | x | START_PG OOD | |
| D5h | SEQUENCE _ORDER | 0x00 | | 0 | x | x | x | x | STOP_ | ORDER | START | ORDER | |
| D6h | IOUT_MOD E | 0b00 | 0000X1 | 0 | x | x | x | x | x | x | IOUT_SHAR E | ССМ | |
| | | PAGE | Val | | | | | | | | | | |
| | 0x00 0x00 | | | | | | | | | | | | |
| D7h | FREQUENC Y_PHASE | 0x01 | 0x08 | 0 | x | | | PHASE_DELA | Y | | CLK | _DIV | |
| | 1_11002 | 0x02 | 0x04 | | | | | | | | | | |
| | | 0x03 | 0x0C | | | | | | | | | | |
| D8h | VREF_COM MAND | C |)x14 | 0 | x | | | V | REF_COMMAI | ND | | | |
| | | PAGE | Val | | | | | | | | | | |
| | | 0x00 | 0x04 | | x | | x | x | x | | | | |
| D9h | IOUT_MAX | 0x01 | 0x04 | 0 | | х | | | | IOUT_MAX | | | |
| | | 0x02 | 0x03 | | | | | | | | | | |
| | | 0x03 | 0x03 | | | | | | | | | | |
| DAh | USER_RAM _00 | C | 0x00 | 0 | x | x | x | x | x | x | x | USER_RAM _00 | |
| DBh | SOFT_RES ET | | | | | | | — | | | | | |
| DCh | RESET_DE LAY | C |)x00 | 0 | x | x | x | x | x | | RESET_DELA | Y | |
| DDh | TON_TOFF _DELAY | C | 0x01 | 0 | x | x | | TON_DELAY | | | TOFF_DELAY | , | |
| DEh | TON_TRAN SITION_RA TE | C |)x02 | 0 | x | x | x | x | x | x | TON_RA | MP_RATE | |

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| | | | | | | | - | | | | | |
|------|------------------------------|---------------|------|----------------------|----------------|--------------------|---------|---------|-----------------|----------------------------|---------|--|
| Code | Name | Default Value | Byte | Bits | | | | | | | | |
| Code | Name | | | 7 (MSB) | 6 | 5 | 4 | 3 | 2 | 1 | 0 (LSB) | |
| DFh | VREF_TRA NSITION_R ATE | 0x98 | 0 | VREF_RAM P_ENABLE | x | VREF_RAMP_TIMESTEP | | | VRE | VREF_RAMP_BITSTEP | | |
| F0h | SLOPE_CO MPENSATI ON | 0x01 | 0 | x | x | x | x | x | x | SLOPE_CO MPENSATI ON | | |
| F1h | ISENSE_GA IN | 0x01 | 0 | x | x | х | x | x | x | ISENSE_GA IN | | |
| FCh | DEVICE_C | 0xFX | 0 | | DEVICE_CODE_ID | | | | DEVICE_CODE_REV | | | |
| FUI | ODE | 0x00 | 1 | | | | DEVICE_ | CODE_ID | | | | |



8.5.1.1 Overview

The TPS65400-Q1 implements a lightweight PMBus-compliant layer supporting packet error checking, high-speed bus, and group commands.

8.5.1.2 PMBus Protocol

The PMBus specification follows SMBus version 2.0. Figure 22 through Figure 29 show all supported command transactions.

8.5.1.2.1 PMBus Protocol

Figure 22. Send Byte Protocol With PEC

| 1 | 7 | 1 | 1 | 8 | 1 | 8 | 1 | 1 |
|-------|------------------|----|-----|--------------|-----|-----|-----|------|
| Start | Slave address | Wr | Ack | Command code | Ack | PEC | Ack | Stop |

Figure 23. Write Byte Protocol With PEC

| 1 | 7 | 1 | 1 | 8 | 1 | 8 | 1 | 8 | 1 | 1 |
|-------|------------------|----|-----|--------------|-----|-----------|-----|-----|-----|------|
| Start | Slave address | Wr | Ack | Command code | Ack | Data byte | Ack | PEC | Ack | Stop |

Figure 24. Read Byte Protocol With PEC

| 1 | 7 | 1 | 1 | 8 | 1 | 1 |
|-------|---------------|----|-----|--------------|-----|---------|
| Start | Slave address | Wr | Ack | Command code | Ack | Restart |

| 7 | 1 | 1 | 8 | 1 | 8 | 1 | 1 |
|---------------|----|-----|-----------|-----|-----|------|------|
| Slave address | Rd | Ack | Data byte | Ack | PEC | Nack | Stop |

Figure 25. Read Word Protocol With PEC

| 1 | 7 | 1 | 1 | 8 | 1 | 1 | 7 | 1 | 1 |
|-------|------------------|----|-----|--------------|-----|---------|------------------|----|-----|
| Start | Slave address | Wr | Ack | Command code | Ack | Restart | Slave address | Rd | Ack |

| 8 | 1 | 8 | 1 | 8 | 1 | 1 |
|-----------------|-----|------------------|-----|-----|------|------|
| Data word (low) | Ack | Data word (high) | Ack | PEC | Nack | Stop |

8.5.1.2.2 Transactions (No PEC)

Figure 26. Send Byte Protocol

| 1 | 7 | 1 | 1 | 8 | 1 | 1 |
|-------|---------------|----|-----|--------------|-----|------|
| Start | Slave address | Wr | Ack | Command code | Ack | Stop |

Figure 27. Write Byte Protocol

| 1 | 7 | 1 | 1 | 8 | 1 | 8 | 1 | 1 |
|-------|------------------|----|-----|--------------|-----|-----------|-----|------|
| Start | Slave address | Wr | Ack | Command code | Ack | Data byte | Ack | Stop |

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| | | Figure 28. | Read By | te Protocol | | |
|---------------|---------------|------------|---------|-------------|--------|---------|
| 1 | 7 | 1 | 1 | 8 | 1 | 1 |
| Start | Slave address | Wr | Ack | Command co | de Ack | Restart |
| | | | | | | |
| 7 | 1 | 1 | | 8 | 1 | 1 |
| Slave address | Rd | Ack | | Data byte | Nack | Stop |

Figure 29. Read Word Protocol

| 1 | 7 | 1 | 1 | 8 | 1 | 8 | 7 | 1 | 1 |
|--------|------------------|----|-----|--------------|-----------|---------|------------------|----|-----|
| Start | Slave address | Wr | Ack | Command code | Ack | Restart | Slave address | Rd | Ack |
| | 8 | | 1 | 3 | 3 | | 1 | | 1 |
| Data w | ord (low) | А | ck | Data wo | rd (high) | N | lack | S | top |

8.5.1.2.3 Addressing

The 7-bit I²C address is set through the I2CADDR terminal with a resistor RADDR connected to AGND. Table 6 shows the connection between the voltage at the I2CADDR terminal and the set I²C address at V_{DDD} = 3 V. The I²C address is determined only upon startup during t_{RESET_DELAY} after rising edge of CE or RST_N. This makes it immune to noise that may occur during normal operation. TI recommends resistors with 5% or lower tolerance. If I²C is not necessary in the application, TI recommends to tie the I2CADDR terminal directly to VDDD.

| Table 0. TC Address Selection | | | | | | |
|-------------------------------|------------------------------|--|--|--|--|--|
| R _{ADDR} | 7-bit Address | | | | | |
| 180 kΩ | 1101 111 | | | | | |
| 120 kΩ | 1101 110 | | | | | |
| 82 kΩ | 1101 101 | | | | | |
| 56 kΩ | 1101 100 | | | | | |
| 39 kΩ | 1101 011 | | | | | |
| 22 kΩ | 1101 010 | | | | | |
| 10 kΩ | 1101 001 | | | | | |
| 2 kΩ | Test mode (factory-use only) | | | | | |
| | | | | | | |

Table 6. I²C Address Selection

8.5.1.2.4 Startup

After CE is asserted and V_{DDD} has reached 3.3 V, there is approximately a 320 µs delay before the PMBus interface is active. During this time the TPS65400-Q1 is restoring its configuration from the EEPROM.

8.5.1.2.5 Bus Speed

100- and 400-kHz bus speeds are supported.

8.5.1.2.6 I2CALERT Terminal

When a timeout condition occurs, the I2CALERT terminal is pulsed low for 200 μ s. A timeout condition is defined as per SMBUS 2.0, t_{TIMEOUT}. In addition to SCL, a timeout condition also occurs when the SDA line is asserted low. If the timeout condition persists, I2CALERT continues to pulse every t_{TIMEOUT}. The TPS65400-Q1 never intentionally pulls the SCL low beyond t_{LOW:SEXT}, as that violates timing specifications. Therefore, the I2CALERT terminal acts as a watchdog for other devices sharing the same bus that violate the cumulative clock low extend time. On a system level, it can be seen as a non-maskable interrupt (NMI) signal for the I²C bus.



Table 7. Timeout Specifications

| | PARAMETER | MIN | MAX | UNIT |
|--------------------------|--------------------------|-----|-----|------|
| t _{TIMEOUT:SCL} | Detect clock low timeout | 25 | 35 | ms |
| t _{TIMEOUT:SDA} | Detect data low timeout | 25 | 35 | ms |

8.5.1.2.7 CONTROL Terminal

The TPS65400-Q1 enable terminals ENSWx are equivalent to the CONTROL terminals in the fault handling. The enable terminals behave as follows:

- Unit does not power up until commanded by the enable terminal and OPERATION command. By default, the OPERATION command is ON, so the powering up of the unit depends on the enable terminal state.
- To start, the unit requires that the on/off portion of the OPERATION command is instructing the unit to run. Depending on PIN_CONFIG_00, the unit may also require the enable terminal to be asserted for the unit to start and energize the output.
- · Polarity of the enable terminal is active high. If unconnected, the terminal goes high.
- When commanding the unit to turn on or off through the enable terminals, the programmed turn on delays, turn off delays are always observed.

There are differences in enable terminal functionality depending on terminal configuration PIN_CONFIG_00. For more information, refer to OPERATION and PIN_CONFIG_00.

8.5.1.2.8 Packet Error Checking

The TPS65400-Q1 supports an optional PEC code to be validated at the end of every write and to be appended to the end of every read. TI highly recommends it, but it is not required.

8.5.1.2.9 Group Commands

Fully-compliant group commands are supported.

8.5.1.2.10 Unsupported Features

All undocumented, optional features are not supported. Extended commands are not supported.

8.5.2 PMBus Register Descriptions

The PMBus specification referenced by this section is *PMBus Power System Management Protocol Specification Part II – Command Language, Revision 1.2*, dated 6 September 2010. The specification is published by the Power Management Bus Implementers Forum and is available from http://pmbus.org/specifications.

8.5.2.1 Overview

The following parameters can be programmed and read. These are individually available for each power supply output (SW1-SW4):

- Voltage reference
- Start sequencing
- Stop sequencing
- Switching frequency
- Switching phase
- Soft-start time
- Current limit
- Current sharing operation with SW1-SW2 and/or SW3-SW4 pairs
- Power Good
- Fault status

Each power supply has its own set of PMBus commands. Paging is supported to allow device selection for a PMBus session ((00h) PAGE). Table 4 lists supported PMBus commands and paging values.

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8.5.2.2 Memory Model

Supported PMBus Commands describes the memory model for PMBus devices. Values used by the PMBus device are loaded into volatile operating memory from the following places:

- Values hard-coded into an IC design
- Values programmed from hardware terminals
- A non-volatile memory called the default store
- Communications from the PMBus

On-board data flash memory is used to implement the hard-coded values and the default store values. Values in the default store may be changed using the STORE_DEFAULT_ALL command described in (11h) STORE_DEFAULT_ALL. The user store is not supported. Table 4 describes the ordering of memory loading and precedence. In general, the hard-coded parameters are loaded into operating memory first. Second, any terminal-programmable settings take effect. Third, values from the default store are loaded. Later, commands issued from the PMBus take effect. In all cases, an operation on a parameter overwrites any prior value that was already in the operating memory.

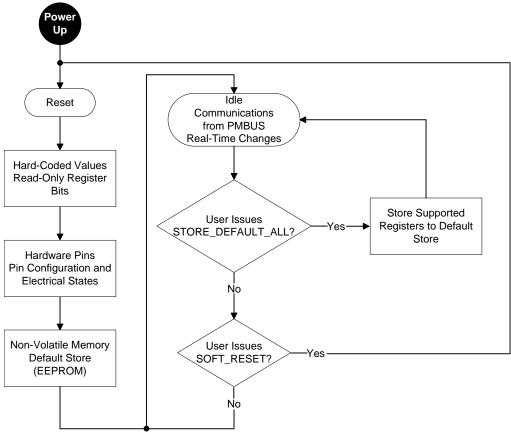


Figure 30. Memory Model

8.5.2.3 Data Formats

Data is sent as a byte, an 8-bit binary value, a word, a 16-bit binary value, or a block of bytes whose length is specified by a length byte.

8.5.2.4 Fault Monitoring

Registers (78h) STATUS_BYTE, (79h) STATUS_WORD, (7Ah) STATUS_VOUT of the PMBus specification describe fault monitoring for PMBus devices. The TPS65400-Q1 only supports reporting faults. Fault conditions are set in the corresponding status register and the host or power system manager can poll it. Any bits set in the status register remain set even if the fault condition is removed or corrected. The fault bits in the status register remain set until one of the following occur:



- The device receives a CLEAR_FAULTS command.
- A RESET signal is asserted by either issuing a SOFT_RESET or by asserting/deasserting the CE terminal.
- Bias power is removed from the PMBus device.

Fault Handling describes fault thresholds and specific response behaviors.

8.5.3 PMBus Core Commands

These PMBus core commands are defined in the PMBus Specification. This section describes details that are unique to the TPS65400-Q1 implementation.

8.5.3.1 (00h) PAGE

The PAGE command provides the ability to configure, control, and monitor multiple outputs on a single TPS65400-Q1 using a single PMBus physical address. All subsequent commands that depend on PAGE are applied to the rail selected by the PAGE command.

Rails are numbered starting with one, while pages are numbered starting at 0. Table 8 shows the relationship between the PMBus PAGE value and the rail number.

| BITS | NAME | READ / WRITE | DEFAULT VALUE | VALUE | OUTPUT RAIL | PAIRING | CURRENT SHARING RELATIONSHIP |
|------|----------|--------------|------------------|---------|-------------|-----------|------------------------------------|
| | | GE R/W | | 0x00 | SW1 | SW1-SW2 | Master |
| | 7:0 PAGE | | 0xFF | 0x01 | SW2 | 5001-5002 | Slave |
| 7.0 | | | | 0x02 | SW3 | SW3-SW4 | Master |
| 7.0 | | | | 0x03 | SW4 | 5005-5004 | Slave |
| | | | 0x04 to 0xFE | Invalid | — | — | |
| | | | | 0xFF | All | | _ |

Table 8. PAGE Data Byte Contents

On the TPS65400-Q1, current share is organized in pairs (PAGE = 0x00, 0x01 and PAGE = 0x02, 0x03). When current sharing mode is detected on a particular pair, the slave PAGE is invalid and the slave's default settings follow that of its master PAGE. The only exception is that the slave switcher PWM will be a fixed 180° phase-shift from its master (see (*D7h*) *FREQUENCY_PHASE*). Additionally, the ISHARE bit will be asserted (see (*D6h*) *IOUT_MODE*).

(00h) PAGE of the register map describes the PAGE command in more detail.

NOTE

The PAGE parameter is not stored in the default store in data flash.

8.5.3.2 (01h) OPERATION

The OPERATION command in conjunction with input from the enable pins ENSWx is used to turn on or off (enable or disable) the currently selected switching regulator as determined by the current PAGE. Margins are not supported. Data byte contents are given in Table 9.

| | | | - | - | | | |
|-----------------------|------------|------------|------------|------------|----------------|---------------------------------|------------------------|
| PAGE SUPPORT | BITS [7:6] | BITS [5:4] | BITS [3:2] | BITS [1:0] | SEQUENCIN G | OUTPUT ON OR OFF | DELAY |
| 0x00 to 0x03, 0xFF | 00 | XX | XX | XX | No | Immediate off | None |
| 0x00 to 0x03 | 01 | XX | XX | XX | No | Soft off | t _{OFF_DELAY} |
| 0xFF | 01 | XX | XX | XX | Yes | Soft off | toff_delay |
| 0x00 to 0x03 | 10 | 00 | XX | XX | No | On with soft-start (default) | t _{ON_DELAY} |

Table 9. Operation Data Byte Contents

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| Table 9. Operation Data Byte Contents (continued) | | | | | | | | |
|---|------------|------------|------------|------------|----------------|---|-----------------------|--|
| PAGE SUPPORT | BITS [7:6] | BITS [5:4] | BITS [3:2] | BITS [1:0] | SEQUENCIN G | OUTPUT ON OR OFF | DELAY | |
| 0xFF | 10 | 00 | XX | XX | Yes | On with soft-start (default ⁽¹⁾) | t _{ON_DELAY} | |

(1) This is also the default behavior upon reset with active ENABLE selected (see (D2h) PIN_CONFIG_00)

Input from the enable pin overrides the off state of the corresponding output. The pin function configuration command PIN_CONFIG_00 can accept or ignore enable pins as well as disable OPERATION sequencing command support (see *(01h) OPERATION*). If the OPERATION state is on, and PIN_CONFIG_00 is set to accept enable pins, action from enable pins would result in a delay specified by TON_TOFF_DELAY. Figure 31 shows how the on/off states are triggered.

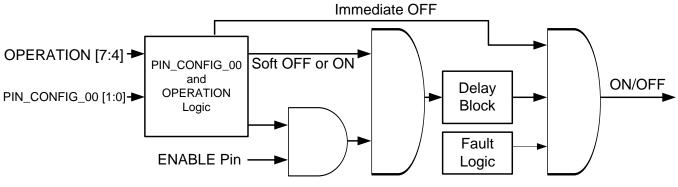


Figure 31. On/Off Configuration (Per Output)

When a fault occurs, the output state will turn OFF and possibly attempt to turn ON repeatedly for persistent faults. Specific fault response behaviors are described in *Fault Handling*.

NOTE

TI recommends that if OPERATION is to be used exclusively, all outputs should be set to the same order and enable pins should be ignored (see *(D5h)* SEQUENCE_ORDER, and *(D2h)* PIN_CONFIG_00).

The OPERATION parameter is not stored in the default store in data flash.

8.5.3.3 (03h) CLEAR_FAULTS

The CLEAR_FAULTS command clears all faults for the selected output. If PAGE 0xFF is selected, all faults for all PAGE outputs are cleared.

NOTE POWER_GOOD_N and OFF indicate the current state of the outputs and cannot be cleared.

8.5.3.4 (10h) WRITE_PROTECT

The WRITE_PROTECT command disables writes on the PMBus. It has one data byte, described in Table 10.

| DATA BYTE VALUE | MEANING |
|------------------------|--|
| 1000 0000 | Disable all writes except to the WRITE_PROTECT command |
| 0100 0000 (default) | Disable all writes except to the WRITE_PROTECT, OPERATION, and PAGE commands |
| 0010 0000 | Disable all writes except to the WRITE_PROTECT, OPERATION, PAGE, and VREF_COMMAND commands |

Table 10. WRITE_PROTECT Command Data Byte Contents



Table 10. WRITE_PROTECT Command Data Byte Contents (continued)

| DATA BYTE VALUE | MEANING |
|-----------------|-------------------------------|
| 0000 0000 | Enable writes to all commands |

If an invalid command is received, a communications fault is set. WRITE_PROTECT does not protect against CLEAR_FAULTS. The user is able to CLEAR_FAULTS anytime regardless of the WRITE_PROTECT state.

This command has no PAGE support.

NOTE

The WRITE_PROTECT parameter is not stored in the default store in data flash.

8.5.3.5 (11h) STORE_DEFAULT_ALL

The STORE_DEFAULT_ALL command saves the PMBus parameters from operating memory into the default store in data flash (EEPROM). The TPS65400-Q1 uses the most recently written set of default store values at startup. The maximum time it takes for the data flash to be written is 70 ms.

This command has no PAGE support.

NOTE

The OPERATION, PAGE, and WRITE_PROTECT parameters are not stored in the default store in data flash.

CAUTION

When STORE_DEFAULT_ALL is issued, operating memory should not be written to during the save.

8.5.3.6 (19h) CAPABILITY

The CAPABILITY command is a read-only command.

This command has no PAGE support.

| | | • | | | | |
|-----|--------------|---------------|--|--|--|--|
| BIT | READ / WRITE | DEFAULT VALUE | MEANING | | | |
| 7 | R | 1 | Packet error checking is supported | | | |
| 6:5 | R | 01 | Maximum supported bus speed is 400 kHz | | | |
| 4 | R | 0 | Device does not have a $\overline{\text{SMBALERT}}$ pin and does not support the SMBus alert response protocol | | | |
| 3:0 | R | 0000 | Reserved | | | |

Table 11. CAPABILITY COMMAND Data Byte Contents

8.5.3.7 (78h) STATUS_BYTE

The STATUS_BYTE command is a read-only command. Write mask is not supported. The bits are listed in Table 12.

| PAGE SUPPORT | BIT | NAME | READ / WRITE | DEFAULT VALUE | MEANING |
|--------------|-----|---------------|--------------|------------------|--------------------------|
| _ | 7 | Not supported | R | 0 | — |
| Yes | 6 | OFF | R | — | Output is off |
| Yes | 5 | VOUT_OV | R | — | Output overvoltage fault |
| Yes | 4 | IOUT_OC | R | — | Output overcurrent fault |

Table 12. STATUS_BYTE Data Byte Contents

| PAGE SUPPORT | BIT | NAME | READ / WRITE | DEFAULT VALUE | MEANING |
|--------------|-----|----------------------|--------------|------------------|--|
| No | 2 | TEMPERATURE | R | — | Overtemperature fault |
| _ | 3 | Not supported | R | 0 | — |
| No | 1 | CML | R | — | Invalid command code, data, or packet |
| Yes | 0 | NONE OF THE ABOVE | R | _ | A fault or warning not listed in bits [7:1] has occurred |

Overtemperature fault and CML is independent of PAGE. When there is PAGE support, the meaning of the bits applies only for the selected output PAGE. For PAGE = 0xFF, STATUS_BYTE is a logical OR of all PAGE = 0x00 to 0x03 STATUS_BYTE values.

An exception to NONE OF THE ABOVE is that the MFR bit in STATUS_WORD is ignored due to no PAGE support.

PAGE support is for outputs 0x00 to 0x03, 0x0FF.

8.5.3.8 (79h) STATUS_WORD

The STATUS_WORD command is a read-only command. Write mask is not supported. Only the parameters in Table 13 are supported.

| PAGE SUPPORT | BIT | NAME | READ / WRITE | DEFAULT VALUE | MEANING | | | |
|--------------|-----|---------------|--------------|------------------|--|--|--|--|
| Yes | 7 | VOUT | R | _ | Output voltage fault set if any bit in STATUS_VOUT is asserted (for the same page) | | | |
| — | 6 | Not supported | R | 0 | — | | | |
| — | 5 | Not supported | R | 0 | _ | | | |
| No | 4 | MFR | R | — | Set if any bit in STATUS_MFR_SPECIFIC is asserted | | | |
| Yes | 3 | POWER_GOOD_N | R | — | Output voltage is within PGOOD range, negated | | | |
| — | 2 | Not supported | R | 0 | — | | | |
| _ | 1 | Not supported | R | 0 | — | | | |
| _ | 0 | Not supported | R | 0 | - | | | |

Table 13. STATUS_WORD Data Word Contents (Upper Byte)

The lower byte of STATUS_WORD is STATUS_BYTE.

The MFR bit is independent of PAGE. When there is PAGE support, the meaning of the bits applies only for the selected output PAGE. For PAGE = 0xFF, STATUS_WORD is a logical OR of all PAGE = 0x00 to 0x03 STATUS_WORD values.

PAGE support is for outputs 0x00 to 0x03, 0x0FF.

8.5.3.9 (7Ah) STATUS_VOUT

The STATUS_VOUT command is a read-only command. Write mask is not supported. Only the parameters in Table 14 are supported.

| | | | • | |
|-----|---------------|--------------|---------------|-------------------------|
| BIT | NAME | READ / WRITE | DEFAULT VALUE | MEANING |
| 7 | VOUT_OV | R | — | VOUT overvoltage fault |
| 6 | Not supported | R | 0 | _ |
| 5 | Not supported | R | 0 | _ |
| 4 | VOUT_UV | R | — | VOUT undervoltage fault |
| 3 | Not supported | R | 0 | — |
| 2 | Not supported | R | 0 | _ |

Table 14. STATUS_VOUT Data Byte Contents



Table 14. STATUS_VOUT Data Byte Contents (continued)

| BIT | NAME | READ / WRITE | DEFAULT VALUE | MEANING |
|-----|---------------|--------------|---------------|---------|
| 1 | Not supported | R | 0 | — |
| 0 | Not supported | R | 0 | — |

STATUS_VOUT shows the voltage output status for the PAGE selected output. For PAGE = 0xFF, STATUS_VOUT is a logical OR of all PAGE = 0x00-0x03 STATUS_ VOUT values. VOUT_OV in STATUS_VOUT is identical to VOUT_OV in STATUS_BYTE for the same PAGE.

PAGE support is for outputs 0x00 to 0x03, 0x0FF.

8.5.3.10 (80h) STATUS_MFR_SPECIFIC

The STATUS_MFR_SPECIFIC command is a read-only command. Write mask is not supported. Only the parameters in Table 15 are supported.

| | | | | 5 |
|-----|---------------|-----------------|------------------|---|
| BIT | NAME | READ / WRITE | DEFAULT VALUE | MEANING |
| 7 | Not supported | R | 0 | — |
| 6 | Not supported | R | 0 | — |
| 5 | Not supported | R | 0 | — |
| 4 | Not supported | R | 0 | - |
| 3 | POWER_GOOD4_N | R | — | SW4 output voltage is within PGOOD range, negated |
| 2 | POWER_GOOD3_N | R | — | SW3 output voltage is within PGOOD range, negated |
| 1 | POWER_GOOD2_N | R | — | SW2 output voltage is within PGOOD range, negated |
| 0 | POWER_GOOD1_N | R | _ | SW1 output voltage is within PGOOD range, negated |

Table 15. STATUS_MFR_SPECIFIC Data Byte Contents

STATUS_MFR_SPECIFIC reports the individual output negated PGOODs. These bit values also can be retrieved from POWER_GOOD_N if an individual output is selected through PAGE.

This command has no PAGE support.

8.5.3.11 (98h) PMBUS_REVISION

The PMBUS_REVISION command is a read-only command.

| Table 16. PMBUS | _REVISION Data Byte Conte | ents |
|-----------------|---------------------------|------|
|-----------------|---------------------------|------|

| BITS | NAME | READ / WRITE | DEFAULT VALUE | MEANING |
|------|------------------|--------------|---------------|----------------------|
| 7:4 | Part I revision | R | 0010 | Supports version 1.2 |
| 3:0 | Part II revision | R | 0010 | Supports version 1.2 |

This command has no PAGE support.

8.5.3.12 (ADh) IC_DEVICE_ID

The IC_DEVICE_ID command is a read-only block command and returns the ASCII characters of the part number TPS65400-Q1.



Table 17. IC_DEVICE_ID Data Block Contents

| BYTE | NAME | READ / WRITE | DEFAULT VALUE | ASCII VALUE |
|------|--------------|--------------|---------------|-------------|
| 7 | | | 0x30 | 0 |
| 6 | | | 0x33 | 3 |
| 5 | | | 0x34 | 4 |
| 4 | IC_DEVICE_ID | R | 0x36 | 6 |
| 3 | | | 0x32 | 2 |
| 2 | | | 0x4D | М |
| 1 | | | 0x4C | L |
| 0 | Length byte | R | 0x07 | _ |

This command has no PAGE support.

8.5.3.13 (AEh) IC_DEVICE_REV

The IC_DEVICE_REV command is a read-only block command and returns the 2-byte device code of the part. The device code is identical to the 2-byte DEVICE_CODE. Refer to DEVICE_CODE for details (see *(FCh) DEVICE_CODE*).

Table 18. IC_DEVICE_REV Data Block Contents

| BYTE | NAME | READ / WRITE | DEFAULT VALUE |
|------|-------------|--------------|-----------------|
| 2:1 | DEVICE_CODE | R | See DEVICE_CODE |
| 0 | Length byte | R | 0x02 |

This command has no PAGE support.

8.5.4 Manufacturer-Specific Commands

8.5.4.1 (D0h) USER_DATA_BYTE_00

The USER_DATA_BYTE_00 command contains 8 bits for reading and writing user-defined data. Upon issuing STORE_DEFAULT_ALL, contents of this command are saved to the default store in data flash.

Table 19. USER_DATA_BYTE_00 Data Byte Contents

| BITS | NAME | READ / WRITE | DEFAULT VALUE |
|------|-------------------|--------------|---------------|
| 7:0 | USER_DATA_BYTE_00 | R/W | 0x00 |

This command has no PAGE support.

8.5.4.2 (D1h) USER_DATA_BYTE_01

The USER_DATA_BYTE_01 command contains 7 bits, USER_DATA_BITS_01, for reading and writing userdefined data. Upon issuing STORE_DEFAULT_ALL, contents of this command are saved to the default store in data flash.

The most significant bit, STORED, is a read-only bit that indicates whether the user has written to the default store through STORE_DEFAULT_ALL. This indicator bit cannot be cleared.

| BITS | NAME | READ / WRITE | DEFAULT VALUE |
|------|-------------------|--------------|---------------|
| 7 | STORED | R | 0 |
| 6:0 | USER_DATA_BYTE_01 | R/W | 000000 |

Table 20. USER DATA BYTE 01 Data Byte Contents





This command has no PAGE support.

8.5.4.3 (D2h) PIN_CONFIG_00

The PIN_CONFIG_00 command selects pin function and behavior for enable pins ENSWx and the global PGOOD pin.

ENABLE_PIN_CONFIG selects between active ENABLE, inactive ENABLE, or single ENABLE behavior for ENSWx pins.

- When active ENABLE is selected, each pin in conjunction with OPERATION controls its respective switcher on/off. For details, see (01h) OPERATION and (DDh) TON_TOFF_DELAY.
- When inactive ENABLE is selected, the state of all ENSWx pins is ignored.
- When single ENABLE is selected, ENSW1 pin acts as a sequence start and sequence stop pin, with all other ENSWx pins ignored. This allows the device to emulate classic sequencing behavior. A start sequence begins when ENSW1 is asserted, and a stop sequence begins when ENSW1 is deasserted. If ENSW1 were to de-assert before a start sequence were complete, a stop-sequence would begin immediately.

PGOOD_PIN_CONFIG sets the function of the global PGOOD pin.

- <u>By default</u>, the global PGOOD pin is configured to output a logical AND of each individual power supply's PGOOD. If all supplies were to turn off, the global PGOOD pin would be de-asserted.
- The global PGOOD pin can be selected to output the status of any individual power supply's PGOOD, or any OR/AND combination thereof. If an individual supply's PGOOD#_MASK bit is masked, its PGOOD status would be masked from the global PGOOD pin. If all PGOOD#_MASK pins were masked, the output of the global PGOOD pin would be at logic zero regardless of the PGOOD_LOGIC selected.
- PGOOD#_MASK only applies to the output pin logic and does not affect STATUS_WORD or sequencing.

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | MEANING | PINS AFFECTED | | |
|------|-----------------------------------|-----------------|------------------|---|--|------------------|---|--|
| 7 | — | R | 0 | _ | — | — | | |
| 6 | PGOOD_PIN_CONFIG | R/W | 0 | 0 | AND of all unmasked PGOODs | | | |
| 0 | : PGOOD_LOGIC | R/W | 0 | 1 | OR of all unmasked PGOODs | | | |
| 5 | PGOOD_PIN_CONFIG | R/W | 4 | 0 | PGOOD4 is masked | | | |
| Э | : PGOOD4_MASK | R/W | I | 1 | PGOOD4 is unmasked | | | |
| 4 | PGOOD_PIN_CONFIG : PGOOD3_MASK | R/W | 1 | 0 | PGOOD3 is masked | Global PGOOD pin | | |
| | | | | 1 | PGOOD3 is unmasked | | | |
| 3 | PGOOD_PIN_CONFIG | R/W | 1 | 0 | PGOOD2 is masked | | | |
| 3 | : PGOOD2_MASK | | I | 1 | PGOOD2 is unmasked | | | |
| 2 | PGOOD_PIN_CONFIG | R/W | 1 | 0 | PGOOD1 is masked | | | |
| 2 | : PGOOD1_MASK | r/ w | I | 1 | PGOOD1 is unmasked | | | |
| | | | | | | 00 | Active ENABLE Enable pins ENSWx control each switcher independently | |
| 1:0 | 1:0 ENABLE_PIN_CONFI G | R/W 00 | 01 | Inactive ENABLE All enable pins ENSWx are ignored | ENSW# pins | | | |
| | | | | 1X | Single ENABLE ENSW1 starts and stops sequencing. All other enable pins are ignored. | | | |

Table 21. PIN_CONFIG_00 Data Byte Contents

Table 22 shows example configurations for PGOOD_PIN_CONFIG.

Table 22. PGOOD_PIN_CONFIG Example Configurations

| PGOOD_PIN_CONFIG BINARY VALUE | GLOBAL PGOOD PIN |
|-------------------------------|---|
| 01111 (default) | PGOOD1 and PGOOD2 and PGOOD3 and PGOOD4 |

| GLOBAL PGOOD PIN |
|-------------------------------------|
| |
| GOOD1 or PGOOD2 or PGOOD3 or PGOOD4 |
| GOOD1 and PGOOD3 |
| GOOD1 |
| GOOD2 |
| GOOD3 |
| GOOD4 |
| G |

Table 22. PGOOD_PIN_CONFIG Example Configurations (continued)

This command has no PAGE support.

CAUTION

Changing PIN_CONFIG_00 during normal operation has no effect. The configuration can only be modified by storing into EEPROM and then reloading the configuration upon reset.

8.5.4.4 (D3h) PIN_CONFIG_01

PIN_CONFIG_01 command selects pin function and behavior for the selected output's SSx/PG pin.

SSPG_PIN_CONFIG sets the selected power supply's SSx/PG pin to a soft-start time input pin or a power good output pin.

- When selected as soft-start time input pin SSx, the internal soft-start ramp rate TON_TRANSITION_RATE is
 ignored. A 5-µA current source will be connected internally and an external capacitor can be used to set the
 soft-start delay.
- When selected as a power good output pin PG (PGOOD), the pin outputs the status of the selected power supply's power good.

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | MEANING | PINS AFFECTED |
|------|--------------|--------------|------------------|--------------|---------|---------------|
| 7:1 | _ | R | 0000000 | _ | — | — |
| 0 | SSPG_PIN_CON | R/W | 0 | 0 | SSx pin | SSx/PG pin |
| | FIG | | | 1 | PG pin | |

Table 23. PIN_CONFIG_01 Data Byte Contents

PAGE support is for outputs 0x00 through 0x03.

CAUTION

Changing PIN_CONFIG_01 during normal operation will have no effect. The configuration can only be modified by storing into EEPROM and then reloading the configuration upon reset.

8.5.4.5 (D4h) SEQUENCE_CONFIG

The SEQUENCE_CONFIG command determines sequencing behavior.

START_PGOOD determines whether the next output in sequence looks at the previous output's PGOOD before turning on. For turning on, the previous output's PGOOD must be good. For the first in sequence, there is no PGOOD reference so START_PGOOD for those particular switchers are ignored. START_PGOOD applies to all switchers.



Table 24. SEQUENCE_CONFIG Data Byte Contents

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | MEANING |
|------|-------------|--------------|---------------|--------------|------------------|
| 7:1 | — | R | 0000000 | — | — |
| 0 | START_PGOOD | R/W | 0 | 0 | PGOOD is checked |
| | | | | 1 | PGOOD is ignored |

This command has no PAGE support.

CAUTION

TI does not recommend changing SEQUENCE_CONFIG during start sequencing or stop sequencing.

8.5.4.6 (D5h) SEQUENCE_ORDER

The SEQUENCE_ORDER command determines the order in which each output starts and stops. If two or more supplies are assigned the same sequence number, they start/stop at the same time. If sequencing is not used, all sequence bits should be set to the same value. For PGOOD sequencing options, see (D4h) SEQUENCE_CONFIG.

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
|------|-------------|--------------|---------------|--------------|--------------------|----------------|
| 7:4 | — | R | 0000 | — | _ | — |
| 3:2 | STOP_ORDER | R/W | 00 | 00 | 1 (first to stop) | Stop sequence |
| | | | | 01 | 2 | order number |
| | | | | 10 | 3 | |
| | | | | 11 | 4 (last to stop) | |
| 1:0 | START_ORDER | R/W | 00 | 00 | 1 (first to start) | Start sequence |
| | | | | 01 | 2 | order number |
| | | | | 10 | 3 | |
| | | | | 11 | 4 (last to start) | |

Table 25. SEQUENCE_ORDER Data Byte Contents

CAUTION

TI does not recommend changing SEQUENCE_ORDER during start sequencing or stop sequencing.

PAGE support is for outputs 0x00 to 0x03.

8.5.4.7 (D6h) IOUT_MODE

The IOUT_MODE command configures the selected output to be:

- Operating in CCM
- Operating in Mixed CCM/DCM

There is a read-only bit, IOUT_SHARE, that indicates that the current selected output:

- Shares its current
- Does not share its current

On the TPS65400-Q1, current share is organized in pairs (PAGE = 0x00, 0x01 and PAGE = 0x02, 0x03). When current sharing mode is detected on a particular pair, the slave PAGE is invalid and the slave's default settings follow that of its master PAGE. The only exception is that the slave switcher PWM is a fixed 180° phase-shift from its master (see (*D7h*) FREQUENCY_PHASE).

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Table 26. IOUT_MODE Data Byte Contents

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | MEANING |
|------|------------|--------------|---------------|------------------|----------------------------------|
| 7:2 | — | R | 000000 | — | — |
| 4 | | R — | | 0 | Current is not shared |
| 1 | IOUT_SHARE | | — | 1 ⁽¹⁾ | Current is shared ⁽¹⁾ |
| 0 | 0014 | D 444 | | 0 | Mixed CCM/DCM |
| 0 | CCM | R/W | | 1 | CCM |

(1) This bit is only observable from the master PAGEs (see (00h) PAGE).

PAGE support is for outputs 0x00 through 0x03.

CAUTION

Changing IOUT_MODE during normal operation has no effect. The configuration can only be modified by storing into EEPROM and then reloading the configuration upon reset.

8.5.4.8 (D7h) FREQUENCY_PHASE

The FREQUENCY_PHASE command sets the output switching frequency and phase of the selected output. The switching frequency is a quotient from the division of the master clock, F_{OSC} , by the selected divisor CLK_DIV. PHASE_DELAY determines the phase shift as a multiple of the internal PLL period, which is scaled at 4x less than the master clock period 1 / F_{OSC} .

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
|-------------|---------------------|---------------------|---------------|----------------|---------------------|---------------------------------|
| 7 | _ | R | 0 | — | — | — |
| | | | | 00000 | 0 | |
| | 6:2 PHASE_DELAY R/W | | 00001 | 1 / (4 × FOSC) | | |
| 6:2 | | R/W | See Table 28 | | | Switching delay time (phase) |
| | | | | 11110 | 30 / (4 × FOSC) | |
| | | | | 11111 | 31 / (4 × FOSC) | |
| | | | | 00 | FOSC / 1 | |
| 1.0 | | | 22 | 01 | FOSC / 2 | Quitabing fragmanay |
| 1:0 CLK_DIV | R/W | 00 | 10 | FOSC / 4 | Switching frequency | |
| | | | | 11 | FOSC / 8 | |

Table 27. FREQUENCY_PHASE Data Byte Contents

Table 28. PHASE_DELAY Default Data Bit Values

| PAGE | PHASE_DELAY BINARY VALUE | PHASE SHIFT (°) |
|------|--------------------------|-----------------|
| 0x00 | 00000 | 0 |
| 0x01 | 00010 | 180 |
| 0x02 | 00001 | 90 |
| 0x03 | 00011 | 270 |

The phase shift in degrees is calculated by Equation 5.

Phase shift =
$$\frac{PHASE_DELAY}{2^{CLK_DIV}}$$
 (degrees)

(5)

When current sharing mode is detected on a particular pair, the slave PAGE is invalid and the slave's default settings follow that of its master PAGE. The only exception is that the slave switcher PWM is a fixed 180° phase-shift from its master. Additionally, the ISHARE bit is asserted (see (*D6h*) IOUT_MODE).

PAGE support is for outputs 0x00 through 0x03.

CAUTION

Changing the FREQUENCY_PHASE during normal operation has no effect. The configuration can only be modified by storing into EEPROM and then reloading the configuration upon reset.

8.5.4.9 (D8h) VREF_COMMAND

The VREF_COMMAND command sets the voltage reference (VREF) for the selected output. Values range from 0.6 to 1.87 V with a bit resolution of 10 mV per LSB.

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
|------|--------------------|--------------|---------------|--------------|--------|-------------------|
| 7 | — | R | 0 | — | — | — |
| | | | | 0000000 | 0.60 V | |
| | | | | 0000001 | 0.61 V | |
| | 6:0 VREF_COMMAND R | | 0010100 | | | |
| 6:0 | | R/W | | 0010100 | 0.8 V | Reference voltage |
| | | | | | | |
| | | | | 1111110 | 1.86 V | |
| | | | | 1111111 | 1.87 V | |

 Table 29. VREF_COMMAND Data Byte Contents

The voltage reference can be changed while one or more voltage outputs are enabled. To reduce the effect of large transient steps, digital slew rate limiting is implemented. The larger the change in the voltage reference, the greater the delay that is incurred as the voltage steps toward the new reference. For details, see *(DFh) VREF_TRANSITION_RATE*.

Faults are blanked during transition. A 100-s fault blanking time results after a transition completes.

PAGE support is for outputs 0x00 through 0x03.

8.5.4.10 (D9h) IOUT_MAX

The IOUT_MAX command sets the current limit for the selected output.

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
|------|----------|--------------|------------------|--------------|-------|---------------|
| 7:3 | — | R | 00000 | — | — | — |
| | | | | 000 | 2 A | |
| | | | | 001 | 3 A | |
| 2:0 | IOUT_MAX | R/W | 100 | 010 | 4 A | Current limit |
| | | | | 011 | 5 A | |
| | | | | 1XX | 6 A | |

| Table 31. IOUT_MAX Data I | yte Contents, PAGE = 0x02, 0x03 |
|---------------------------|---------------------------------|
|---------------------------|---------------------------------|

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
|--------------|------|--------------|------------------|--------------|---------------|---------------|
| 7:2 | — | R | 000000 | — | — | — |
| | | DAM | 11 | 00 | 0.5 A | |
| 1.0 | | | | 01 | 1 A | Current limit |
| 1:0 IOUT_MAX | R/W | 11 | 10 | 2 A | Current limit | |
| | | | | 11 | 3 A | |

The limit set by the IOUT_MAX byte sets both the high-side and low-side current limit.

PAGE support is for outputs 0x00 through 0x03.

8.5.4.11 (DAh) USER_RAM_00

The USER_RAM_00 command is a reset notification status. Upon any RESET condition, the device clears this value to 0x00. This value can only be set to 0x01 by the PMBus master.

| BITS | NAME | READ / WRITE | DEFAULT VALUE |
|------|-------------|--------------|---------------|
| 7:1 | _ | R | 0000000 |
| 0 | USER_RAM_00 | R/W | 0 |

This command has no PAGE support.

8.5.4.12 (DBh) SOFT_RESET

The SOFT_RESET command triggers a software reset of the device. It is equivalent to sending an assertdeasserting pulse to the CE pin. Consequently, all switchers turn off and all faults are cleared.

This command has no PAGE support.

8.5.4.13 (DCh) RESET_DELAY

The RESET_DELAY command sets the delay time before any switcher can begin its soft-start after CE is asserted. Thus, if the turn-on sequence or an individual switcher is enabled before this delay is over, no action occurs until the delay is completed. After this delay period is passed, enabling the turn-on sequence of an individual switcher would have an immediate effect subject to the t_{ON DELAY} and soft-start time.

| | - | | | | | | | | | |
|------|-------------|----------------|------------------|--------------|---------------------|------------------|------------------|--|--|-----|
| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING | | | | |
| 7:3 | _ | R | 00000 | — | _ | — | | | | |
| | | | | 000 | 1 ms ⁽²⁾ | | | | | |
| | | | | 001 | 50 ms | | | | | |
| | | | | 010 | 100 ms | | | | | |
| 0.0 | | DAA | D44/ 000 | 011 | 250 ms | Deset delau time | | | | |
| 2:0 | RESET_DELAY | ESET_DELAT R/W | R/W | R/W 000 - | 100 | 500 ms | Reset delay time | | | |
| | | | | | | | | | | 101 |
| | | | | 110 | 1500 ms | | | | | |
| | | | | 111 | 2000 ms | | | | | |

Table 33. RESET_DELAY Data Byte Contents⁽¹⁾

(1) All the delay times are subject to the delay between the rising edge of CE and the stabilizing delay time of the VDDD supply, which can be up to 1.1 ms, depending on the bypass capacitor sizing for these rails. The RESET_DELAY in the table is in addition to this power-up delay and has an accuracy of ±62.5 µs.

(2) When setting the RESET_DELAY to 1 ms, TI recommends that the t_{ON_DELAY} for the outputs starting up first be greater than 5 ms. Because, the COMP pin precharge starts at the same time as the RESET_DELAY. If RESET_DELAY is 1 ms, and t_{ON_DELAY} is 0 ms, then the COMP pin precharge may not stabilize before the switcher soft-start begins. The time needed to stabilize the COMP pin precharge depends on the RC compensation values connected to the COMP pin.

This command has no PAGE support.

8.5.4.14 (DDh) TON_TOFF_DELAY

The TON_TOFF_DELAY command sets the delay times after receiving an on or off command for the selected output to begin turning on or off.

TON_DELAY of this command are lexically equivalent to TON_DELAY. If TON_DELAY is set to 0 ms, the device would begin turning on immediately. If TOFF_DELAY is set to 0 ms, the device would begin turning off immediately.



BITS

MEANING

| | Table 34. TON_TOFF_DELAY Data Byte Contents | | | | | | | | | |
|------|---|------------------|--------------|-------|--|--|--|--|--|--|
| NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | | | | | | |
| _ | R | 00 | — | — | | | | | | |
| | | | | | | | | | | |

| Biro | NAME | WRITE | VALUE | BINANT VALUE | TALOL | MEANING |
|------|------------|-------|-------|--------------|---------|----------------------------|
| 7:6 | — | R | 00 | — | — | — |
| 5:3 | TON_DELAY | R/W | 010 | 000 | 0 ms | Delay time before starting |
| | | | | 001 | 1 ms | |
| | | | | 010 | 5 ms | |
| | | | | 011 | 25 ms | |
| | | | | 100 | 100 ms | |
| | | | | 101 | 500 ms | |
| | | | | 110 | 1000 ms | |
| | | | | 111 | 2000 ms | |
| 2:0 | TOFF_DELAY | R/W | 000 | 000 | 0 ms | Delay time before stopping |
| | | | | 001 | 1 ms | |
| | | | | 010 | 5 ms | |
| | | | | 011 | 25 ms | |
| | | | | 100 | 100 ms | |
| | | | | 101 | 500 ms | |
| | | | | 110 | 1000 ms | |
| | | | | 111 | 2000 ms | |

These delays are always in effect including when the outputs are internally or externally sequenced, or arbitrarily turned on or off. The only exceptions are:

- The device receives an immediate OFF from the OPERATION command.
- The device turns its output off internally (such as in a fault condition).

PAGE support is for outputs 0x00 through 0x03.

8.5.4.15 (DEh) TON_TRANSITION_RATE

The TON TRANSITION RATE command sets the soft-start ramp rate for the selected output. This command is ignored by default because soft-start is set externally through the SSx/PG pin. Only when the SSx/PG pin is configured as PG through PIN CONFIG 01 will TON TRANSITION RATE determine the soft-start rate.

The soft-start ramp rate refers to the rate at which the reference voltage is increased. The time to complete the soft-start can be calculated from the target reference voltage as Equation 6.

$$t_{ss} = \frac{Vref}{Soft start ramp rate}$$

(6)

For example, if VREF is set to 0.6 V and the default soft-start ramp rate of 0.5 V/ms is selected, then the softstart time would be 1.2 ms. If VREF is set to 1 V and the soft-start ramp rate of 0.25 V/ms is selected, then the soft-start time would be 4 ms.

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING | |
|------|---------------|-------------------------|------------------|--------------|-----------|-------------------------|--|
| 7:2 | — | R | 000000 | — | — | — | |
| | | | | | 00 | 2 V/ms | |
| 1.0 | TON DAMP DATE | DAA | 10 | 01 | 1 V/ms | Catt start manains rate | |
| 1:0 | TON_RAMP_RATE | TON_RAMP_RATE R/W 10 10 | | 10 | 0.5 V/ms | Soft-start ramping rate | |
| | | | | 11 | 0.25 V/ms | | |

Table 35. TON_TRANSITION_RATE Data Byte Contents

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PAGE support is for outputs 0x00 through 0x03.

8.5.4.16 (DFh) VREF_TRANSITION_RATE

The VREF_TRANSITION_RATE command determines the stepping rate and stepping size when dynamically switching the reference voltage VREF of the selected output.

| | | | | - | | |
|------|--------------------|--------------|------------------|--------------|--------------|---|
| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
| 7 | VREF_RAMP_ENABLE | R/W | 1 | 0 | — | Ramping disabled |
| | | | | 1 | — | Ramping enabled |
| 6 | — | R | 0 | — | — | — |
| 5:3 | VREF_RAMP_TIMESTEP | R/W | 011 | 000 | 1 µs | Delay time per ramping |
| | | | | 001 | 2 µs | step |
| | | | | 010 | 3 µs | |
| | | | | 011 | 4 µs | |
| | | | | 100 | 6 µs | |
| | | | | 101 | 8 µs | |
| | | | | 110 | 12 µs | |
| | | | | 111 | 16 µs | |
| 2:0 | VREF_RAMP_BITSTEP | R/W | 000 | See Table 37 | See Table 37 | Ramp up and ramp down LSB increments / decrements |

Table 36. VREF_TRANSITION_RATE Data Byte Contents

Table 37. VREF_RAMP_BITSTEP Data Bit Values

| VREF_RAMP_BITSTEP BINARY VALUE | RAMP UP (LSB increments) | RAMP DOWN (LSB decrements) |
|--------------------------------|--------------------------|----------------------------|
| 000 (default) | 1 | 1 |
| 001 | 2 | 1 |
| 010 | 4 | 2 |
| 011 | 6 | 3 |
| 100 | 8 | 4 |
| 101 | 10 | 5 |
| 110 | 12 | 6 |
| 111 | 16 | 8 |

VREF_RAMP_BITSTEP sets the amount of voltage reference bits to ramp up and ramp down per VREF_RAMP_TIMESTEP time. During ramping, if the target step is less than or equal to the VREF_RAMP_BITSTEP setting, ramping reduces to a fine voltage step of 1 LSB per VREF_RAMP_TIMESTEP time until the target voltage has been reached. For the actual voltage change per LSB, refer to *(D8h) VREF_COMMAND*.

PAGE support is for outputs 0x00 through 0x03.

8.5.4.17 (F0h) SLOPE_COMPENSATION

The SLOPE_COMPENSATION command modifies control loop compensation parameters to compensate for inductor ripple current harmonics from switching.

| | ······································ | | | | | | | | |
|------|--|--------------|------------------|--------------|-------|---------|--|--|--|
| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING | | | |
| 7:2 | — | R | 000000 | — | | — | | | |

Table 38. SLOPE_COMPENSATION Data Byte Contents

(7)

(8)

Table 38. SLOPE_COMPENSATION Data Byte Contents (continued)

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING | |
|------|--------------------|--------------|------------------|---------------------------|-----------|-----------|--------------|
| | | | | 00 | 45 mV/µs | | |
| 4.0 | | R/W | 01 | 01 | 70 mV/µs | Slope | |
| 1:0 | SLOPE_COMPENSATION | | | SECRE_COMPENSATION N/W 01 | 10 | 100 mV/µs | compensation |
| | | | | 11 | 145 mV/µs | | |

The default slope compensation will be adequate for most applications. The equivalent current slope compensation ramp on the inductor can be found by the following formula:

$$\Delta I_{L} = -G_{mps} \times SL_{comp} \qquad (A/S)$$

Where Gmps is the current sense gain of the peak current control to COMP voltage in Amps per Volt and SLcomp is the slope compensation voltage expressed in the table above.

Ideal slope compensation is achieved when:

$$\left|\Delta I_{L}\right| > \frac{V_{out}}{L}$$

PAGE support is for outputs 0x00 through 0x03.

8.5.4.18 (F1h) ISENSE_GAIN

The ISENSE_GAIN command modifies the current sense G_{mps} of the feedback loop for the selected output. *(F0h)* SLOPE_COMPENSATION describes the equivalent current slope compensation ramp on the inductor.

Table 39. ISENSE_GAIN Data Byte Contents, PAGE = 0x00, 0x01

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
|------|-------------|---------------------|---------------|--------------|---------|--------------------|
| 7:2 | — | R | 000000 | — | _ | — |
| 1:0 | ISENSE_GAIN | R/W | 01 | 00 | 20 A/V | Current sense gain |
| | | | | 01 | 10 A/V | |
| | | | | 10 | 5 A/V | |
| | | | | 11 | 2.5 A/V | |

| BITS | NAME | READ / WRITE | DEFAULT VALUE | BINARY VALUE | VALUE | MEANING |
|------|-------------|--------------|---------------|--------------|----------|--------------------|
| 7:2 | — | R | 000000 | _ | _ | — |
| 1:0 | ISENSE_GAIN | R/W | 01 | 00 | 10 A/V | Current sense gain |
| | | | | 01 | 5 A/V | |
| | | | | 10 | 2.5 A/V | |
| | | | | 11 | 1.25 A/V | |

 Table 40. ISENSE_GAIN Data Byte Contents, PAGE = 0x02, 0x03

PAGE support is for outputs 0x00 through 0x03.

8.5.4.19 (FCh) DEVICE_CODE

The DEVICE_CODE command returns a 2-byte read-only device code. For the TPS65400-Q1, this is 0x00FX, where 'X' is the revision/version number. This command has no PAGE support.

| BITS | NAME | READ / WRITE | DEFAULT VALUE |
|------|-----------------|--------------|---------------|
| 15:4 | DEVICE_CODE_ID | R | 0x00F |
| 3:0 | DEVICE_CODE_REV | R | Х |

Table 41. DEVICE_CODE Data Word Contents

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9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The TPS65400-Q1 PMU is designed to support the trend towards smaller space-constrained systems, which require high-efficiency to limit power dissipation in a closed environment. The TPS65400-Q1 is intended to provide a complete highly-efficiency power management solution in a small form factor while providing maximum control through the I²C bus and ease of use.

The TPS65400-Q1 can support input voltages from 4.5 to 18 V, allowing it to be used in systems powered from a single 5- or 12-V intermediate power bus. High system power conversion efficiency is achieved by providing a single-stage conversion from, for example, the 12-V input voltage to the high-current voltage rails required by the digital circuits.

The two buck regulators SW1 and SW2 can provide an output voltage in the range of 0.6 V to 90%Vin and up to 4-A peak continuous current.

The two buck regulators SW3 and SW4 can provide an output voltage in the range of 0.6 V to 90%Vin and up to 2-A peak continuous current.



9.2 Typical Applications

9.2.1 Internal Operation Typical Application

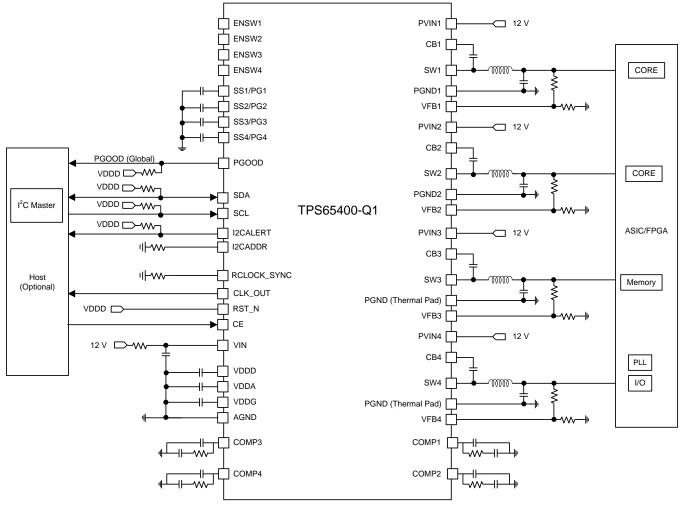


Figure 32. Typical Application Schematic

9.2.1.1 Design Requirements

Table 42 lists PMBus commands to configure this device.

| COMMAND NAME | CODE | NAME | BITS | COMMENT | |
|-------------------|------|---------------------------------------|------|--------------------------------------|--|
| PAGE | 00h | — | 7:0 | Selects output rail | |
| STORE_DEFAULT_ALL | 11h | — | — | Save settings as default | |
| | D2h | PGOOD_PIN_CONFIG | 6:2 | Configure PGOOD pin to mask PGOOD4 | |
| PIN_CONFIG_00 | D2fi | ENABLE_PIN_CONFIG ⁽¹⁾ | 1:0 | Active ENABLE (manufacturer default) | |
| PIN_CONFIG_01 | D3h | SSPG_PIN_CONFIG 0 Set to PG for inte | | Set to PG for internal soft-start | |
| SEQUENCE_CONFIG | D4h | START_PGOOD 0 Disable PGOOD dependent | | Disable PGOOD dependence | |
| SEQUENCE_ORDER | D5h | START_ORDER | 3:2 | Start sequence order | |
| | Don | STOP_ORDER | 1:0 | Stop sequence order | |
| RESET_DELAY | DCh | RESET_DELAY ⁽¹⁾ | 2:0 | Reset delay time | |

(1) Only necessary if the defaults have been overwritten since device manufacture

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Typical Applications (continued)

| COMMAND NAME | CODE | NAME | BITS | COMMENT |
|---------------------|------|---------------|------|----------------------------------|
| TON_TOFF_DELAY | DDh | TON_DELAY | 5:3 | Delay time before starting |
| | | TOFF_DELAY | 2:0 | Delay time before stopping |
| TON_TRANSITION_RATE | DEh | TON_RAMP_RATE | 1:0 | Internal soft-start ramping rate |

To achieve the timing requirements shown in Table 42, an example configuration script is shown in Table 43.

| COMMAND NAME | CODE | WRITE BYTE | COMMENT |
|----------------------------|------|---------------|---|
| PAGE | 00h | 0xFF | Selects all |
| PIN_CONFIG_00 | D2h | 0x1C | PGOOD pin is a function of PGOOD1 and PGOOD2 and PGOOD3 |
| SEQUENCE_CONFIG | D4h | 0x01 | Disable PGOOD dependence |
| RESET_DELAY ⁽¹⁾ | DCh | 0x02 | 100-ms reset delay |
| PAGE | 00h | 0x00 | Selects SW1 |
| PIN_CONFIG_01 | D3h | 0x01 | Configure SS1/PG1 pin to PG1 for internal soft-start |
| SEQUENCE_ORDER | D5h | 0x08 | First to Start, third to Stop |
| TON_TOFF_DELAY | DDh | 0x04 | 0-ms turn-on delay 100-ms turn-off delay |
| TON_TRANSITION_RATE | DEh | TON_RAMP_RATE | Internal soft-start ramping rate |
| PAGE | 00h | 0x02 | Selects SW3 |
| PIN_CONFIG_01 | D3h | 0x01 | Configure SS3/PG3 pin to PG3 for internal soft-start |
| SEQUENCE_ORDER | D5h | 0x05 | Second to start, second to stop |
| TON_TOFF_DELAY | DDh | 0x23 | 100-ms turn-on delay 25-ms turn-off delay |
| TON_TRANSITION_RATE | DEh | TON_RAMP_RATE | Internal soft-start ramping rate |
| PAGE | 00h | 0x01 | Selects SW2 |
| PIN_CONFIG_01 | D3h | 0x01 | Configure SS2/PG2 pin to PG2 for internal soft-start |
| SEQUENCE_ORDER | D5h | 0x02 | Third to start, first to stop |
| TON_TOFF_DELAY | DDh | 0x23 | 100-ms turn-on delay 25-ms turn-off delay |
| TON_TRANSITION_RATE | DEh | TON_RAMP_RATE | Internal soft-start ramping rate |
| STORE_DEFAULT_ALL | 11h | _ | Save settings as default |

Table 43. Example Configuration Script for Internal Operation

(1) Only necessary if the defaults have been overwritten after device manufacture.

9.2.1.2 Detailed Design Procedure

9.2.1.2.1 Component Selection

9.2.1.2.1.1 Output Inductor Selection

Equation 9 gives the current ripple flowing in the inductor in CCM.

$$\Delta I_{L} = \frac{V_{out} \times \left(1 - \frac{V_{out}}{V_{in}}\right)}{L \times f_{sw}}$$

where

- ΔI_L is the current ripple in the inductor.
- V_{out} is the output voltage.
- V_{in} is the input voltage of the converter.
- L is the value of the inductor in henry.



• *f*_{SW} is the switching frequency of the converter.

Typically, the value of L is chosen to have the ripple current be $0.1 \times to 0.3 \times the$ full-load current. Choose the inductor so that the saturation current is higher than the maximum expected current plus half the current ripple at maximum operating temperature.

9.2.1.2.1.2 Output Capacitor Selection

The output capacitor needs to be properly sized to reduce voltage ripple due to the switching action (ripple voltage) and to reduce output voltage swings during transient load currents. Equation 10 gives the output voltage ripple.

$$\Delta V_{out_ripple} = \frac{(V_{in} - V_{out}) \times V_{out}}{8f_{sw}^2 \times C \times L \times V_{in}}$$
(10)

Equation 11 gives the voltage variation during output current transients.

$$\Delta V_{out_transient} = \frac{\Delta I_{out_transient}^{2} \times L}{C_{o} \times V_{out}}$$
(11)

9.2.1.2.2 Internal Operation With Some Switchers Disabled

For applications where the internal settings for sequencing and soft-start are sufficient, all used output rails should have their enable terminals ENSWx tied high or floating and all unused output rails should have their enable pins ENSWx tied low for the default active ENABLE setting of ENABLE_PIN_CONFIG. This prevents the device from turning on an unused output by software default from an OPERATION ON request. This requirement extends to unpowered switchers; if a pair of switchers is unused, then both ENSWx pins must be tied low.

9.2.1.2.3 Internal Operation With All Switchers Enabled

For applications where all outputs rails will be used, it is sufficient to leave all enable terminals ENSWx disconnected and to set ENABLE_PIN_CONFIG to inactive.

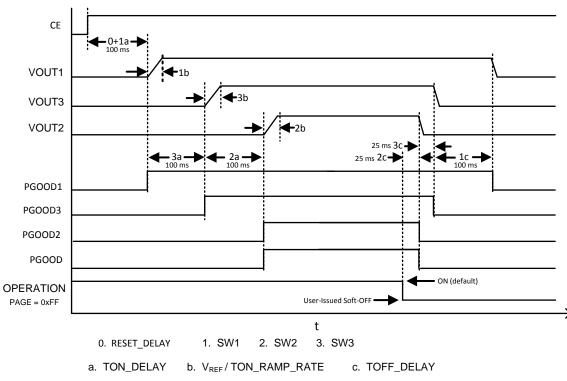
9.2.1.2.4 Example Configuration

Figure 33 shows an internal sequencing schematic example where only switchers 1 to 3 are used for a set of timing requirements. If the internal configuration and fault handling is sufficient, and provided that the user configures the chip through SDA/SCL before placing it on a target board, then it is not necessary for a supervisory and housekeeping host controller chip like a MCU or DSP to be connected to the TPS65400-Q1. In such a case, digital terminals PGOOD, SSx/PG, SDA/SCL, I2CALERT, and CLK_OUT can be left unconnected with no pull-ups required, during normal operation. RST_N can be tied directly to VDDD (no pull-up required). I2CADDR can be tied directly to VDDD after programming. Control line CE can be left unconnected if the chip is constantly powered after VIN is provided.

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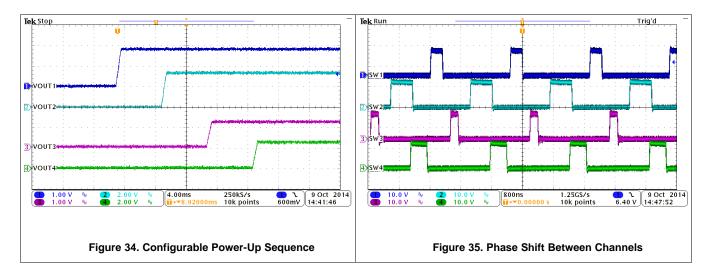


PGOOD dependence disabled, switcher 4 disabled

Figure 33. Example Timing Diagram for Internal Sequencing

9.2.1.2.5 Unused Switchers

If the default setting active ENABLE of ENABLE_PIN_CONFIG is selected, ENSWx for unused switchers must always be tied low.



9.2.1.3 Application Curves



11 1% Vref3 Accuracy Vref1 Step 10.8 Vref1 Accuracy Vref2 Accuracy Vref2 Step 0.8% Vref3 Step Vref4 Step 10.6 Vref4 Accuracy 10.4 V_{REF} Accuracy (%) 0.6% V_{REF} Step (mV) 10.2 0.4% 10 9.8 0.2% 9.6 9.4 0 9.2 -0.2% 9 0 25 50 75 100 125 0 25 50 75 100 125 150 Code Code D006 D007 Figure 36. V_{REF} Accuracy vs Code Figure 37. V_{REF} Step Accuracy vs Code 1.816 3.315 1.815 3.31 1.814 3.305 1.813 Vout1 (V) Vout2 (V) 1.812 3.3 1.811 3.295 1.81 3.29 1.809 1.808 3.285 0 1 2 3 0 1 2 3 4 4 I_{OUT1} (A) I_{OUT2} (A) D008 Figure 38. V_{OUT1} Load Regulation Figure 39. V_{OUT2} Load Regulation 1.2095 1.211 1.209 1.2085 1.21 () 1.208 1.2075 Vout4 (V) 1.209 1.207 1.2065 1.206 1.208 0 0.5 1.5 2 0 0.5 1.5 2 1 1 I_{OUT3} (A) I_{OUT4} (A) D010 D011 Figure 40. V_{OUT3} Load Regulation Figure 41. V_{OUT4} Load Regulation

9.2.2 Current Sharing Typical Application

An example configuration is shown where both pairs of outputs are current shared. Soft-start time is configured externally with capacitors (this is the default setting) and ENABLE_PIN_CONFIG is set to single ENABLE.

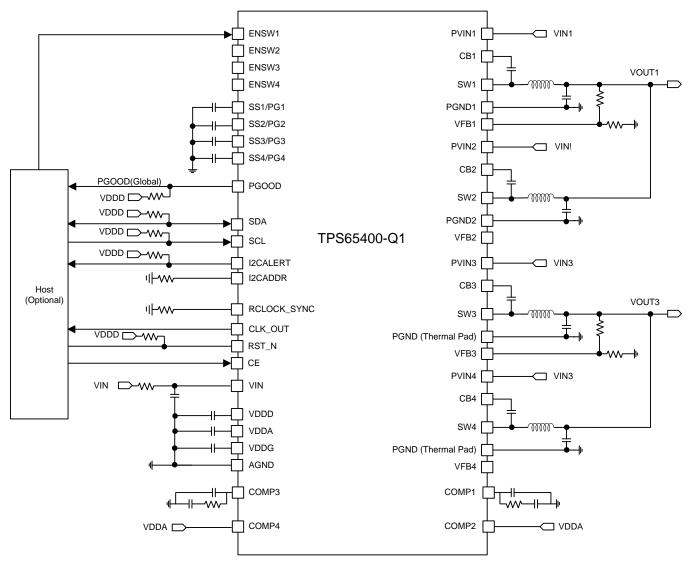


Figure 42. Current Sharing Schematic

SEQUENCE_ORDER

TON_TOFF_DELAY

9.2.2.1 Design Requirements

Table 44 lists PMBus commands to configure this device.

D5h

DDh

| COMMAND NAME | CODE | NAME | BITS | COMMENT |
|-------------------|------|---------------------------------|------|---|
| PAGE | 00h | — | 7:0 | Selects output rail |
| STORE_DEFAULT_ALL | 11h | — | — | Save settings as default |
| PIN_CONFIG_00 | D G | PGOOD_PIN_CONFIG ⁽¹⁾ | 6:2 | PGOOD pin and of all PGOOD (manufacturer default) |
| | D2h | ENABLE_PIN_CONFIG | 1:0 | Single ENABLE |
| PIN_CONFIG_01 | D3h | SSPG_PIN_CONFIG ⁽¹⁾ | 0 | Set to SSx for external soft-start (manufacturer default) |
| SEQUENCE_CONFIG | D4h | START_PGOOD ⁽¹⁾ | 0 | Enable PGOOD dependence (manufacturer default) |
| | DCh | START_ORDER | 3:2 | Start sequence order |

Table 44. PMBus Commands Used for Current Sharing With Single-Pin Enable⁽¹⁾

(1) Only necessary if the defaults have been overwritten since device manufacture.

STOP_ORDER

TON_DELAY

TOFF_DELAY

To achieve the timing requirements shown in Table 44, see the example configuration script in Table 45.

Table 45. Example Configuration Script for Current Sharing With Single-Pin Enable

1:0

5:3

2:0

Stop sequence order

Delay time before starting

Delay time before stopping

| COMMAND NAME | CODE | WRITE BYTE | COMMENT |
|--------------------------------|------|------------|---|
| PAGE | 00h | | Selects all |
| PIN_CONFIG_00 | D2h | | Single ENABLE |
| SEQUENCE_CONFIG ⁽¹⁾ | D4h | | Enable PGOOD dependence (manufacturer default) |
| PAGE | 00h | | Selects SW1 to SW2 pair |
| PIN_CONFIG_01 ⁽¹⁾ | D3h | | Configure SS1/PG1 pin to SS1 for external soft-start (manufacturer default) |
| SEQUENCE_ORDER | D5h | 0x04 | First to start, second to stop |
| TON_TOFF_DELAY | DDh | 0x24 | 100-ms turn-on delay 100-ms turn-off delay |
| PAGE | 00h | 0x02 | Selects SW3 to SW4 pair |
| PIN_CONFIG_01 ⁽¹⁾ | D3h | 0x00 | Configure SS2/PG2 pin to SS2 for external soft-start (manufacturer default) |
| SEQUENCE_ORDER | D5h | 0x01 | Second to start, first to stop |
| TON_TOFF_DELAY | DDh | 0x23 | 100-ms turn-on delay 25-ms turn-off delay |
| STORE_DEFAULT_ALL | 11h | | Save settings as default |

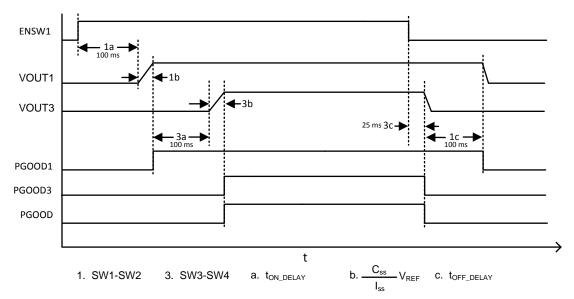
(1) Only necessary if the defaults have been overwritten since device manufacture.

9.2.2.2 Detailed Design Procedure

9.2.2.2.1 Current Sharing Timing Example

Figure 43 shows an example configuration in which both the SW1-SW2 pair and SW3-SW4 pair are current shared. The enable pin of the slave converter can either follow the master converter or be floating. For the PGOOD pin, the slave PGOOD follows the master PGOOD. Due to internal pull-ups to VDDD on ENSWx lines, the user has an option to control ENSWx if an always on condition is desired.





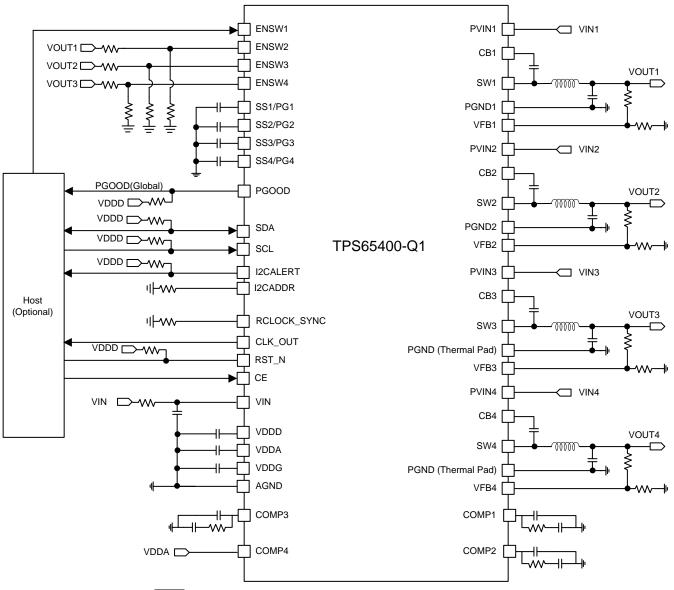
A. External soft-start, single ENABLE

Figure 43. Example Timing Diagram for Current Sharing With Single-Pin Enable



9.2.3 External Sequencing Application

Figure 44 shows an example configuration where the VOUT outputs are linked to enable terminal ENSWx inputs in a daisy-chain configuration for start sequence SW1-SW2-SW3-SW4.



A. Sequencing through VOUT



9.2.3.1 Design Requirements

Table 46 and Table 47 list PMBus commands to configure this device.

Table 46. PMBus Commands Used for External Sequencing through VOUT

| COMMAND NAME | CODE | NAME | BITS | COMMENT |
|-------------------|------|----------------------------------|------|---|
| PAGE | 00h | — | 7:0 | Selects output rail |
| STORE_DEFAULT_ALL | 11h | — | — | Save settings as default |
| PIN_CONFIG_00 | Dah | PGOOD_PIN_CONFIG ⁽¹⁾ | 6:2 | PGOOD pin and of all PGOOD (manufacturer default) |
| | D2h | ENABLE_PIN_CONFIG ⁽¹⁾ | 1:0 | Active ENABLE (manufacturer default) |
| PIN_CONFIG_01 | D3h | SSPG_PIN_CONFIG ⁽¹⁾ | 0 | Set to SSx for external soft-start (manufacturer default) |
| TON TOFE DELAY | | TON_DELAY | 5:3 | Delay time before starting |
| TON_TOFF_DELAY | DDh | TOFF_DELAY ⁽¹⁾ | 2:0 | Delay time before stopping |
| RESET_DELAY | DCh | RESET_DELAY ⁽¹⁾ | 2:0 | Reset delay time |

(1) Only necessary if the defaults have been overwritten since device manufacture.

To achieve the timing requirements shown in Table 46, see Table 47 for an example configuration script.

| Table 47. Example Configuration Script for External Sequencing through VOOT | | | | | | | | | |
|---|------|------------|--|--|--|--|--|--|--|
| COMMAND NAME | CODE | WRITE BYTE | COMMENT | | | | | | |
| PAGE | 00h | 0xFF | Selects all | | | | | | |
| PIN_CONFIG_00 ⁽¹⁾ | D2h | 0x3C | Active ENABLE (manufacturer default) | | | | | | |
| RESET_DELAY ⁽¹⁾ | DCh | 0x02 | 100-ms reset delay | | | | | | |
| PAGE | 00h | 0x00 | Selects SW1 | | | | | | |
| PIN_CONFIG_01 ⁽¹⁾ | D3h | 0x00 | Configure SS1/PG1 pin to SS1 for external soft-start | | | | | | |
| TON_TOFF_DELAY | DDh | 0x20 | 100-ms turn-on delay 0-ms turn-off delay | | | | | | |
| PAGE | 00h | 0x01 | Selects SW2 | | | | | | |
| PIN_CONFIG_01 ⁽¹⁾ | D3h | 0x00 | Configure SS2/PG2 pin to SS2 for external soft-start | | | | | | |
| TON_TOFF_DELAY | DDh | 0x20 | 100-ms turn-on delay 0-ms turn-off delay | | | | | | |
| PAGE | 00h | 0x02 | Selects SW3 | | | | | | |
| PIN_CONFIG_01 ⁽¹⁾ | D3h | 0x00 | Configure SS3/PG3 pin to SS3 for external soft-start | | | | | | |
| TON_TOFF_DELAY | DDh | 0x20 | 100-ms turn-on delay 0-ms turn-off delay | | | | | | |
| PAGE | 00h | 0x03 | Selects SW4 | | | | | | |
| PIN_CONFIG_01 ⁽¹⁾ | D3h | 0x00 | Configure SS4/PG4 pin to SS4 for external soft-start | | | | | | |
| TON_TOFF_DELAY | DDh | 0x20 | 100-ms turn-on delay 0-ms turn-off delay | | | | | | |
| STORE_DEFAULT_ALL | 11h | _ | Save settings as default | | | | | | |

Table 47. Example Configuration Script for External Sequencing through VOUT

(1) Only necessary if the defaults have been overwritten since device manufacture.

9.2.3.2 Detailed Design Procedure

9.2.3.2.1 External Sequencing Through PG Pins

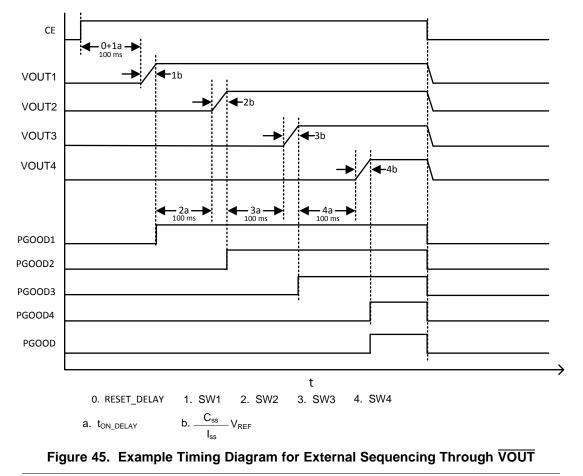
In an application where the programmable soft-start ramping rate is sufficient and where stop sequencing is not required, it is possible to wire Power Good pins (global PGOOD, PG) to enable pins (ENSWx) according to the desired start sequence. This is useful in cases where multiple PMUs are configured and the PG or global PGOOD output of one PMU is required to turn on an output of another PMU.

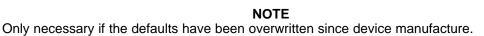
9.2.3.2.2 External Sequencing Through SW

In an application where output voltages exceed the threshold voltage of the enable pins ENSWx, it is possible to wire a properly divided VOUT directly to the enable pins according to the desired start sequence.



9.2.3.2.3 Example Configuration





10 Power Supply Recommendations

This device is designed to operate from an input voltage supply range between 4.5 and 18 V. This input power supply should be well regulated. If the input supply is located more than a few inches from the TPS65400-Q1 converter, additional bulk capacitance may be required in addition to the ceramic bypass capacitors. An electrolytic capacitor with a value of 47 μ F is a typical choice.

11 Layout

11.1 Layout Guidelines

Layout is a critical portion of high-current multi-channel DC-DC. Follow these guidelines for layout. See *Layout Example* for a PCB layout example.

- Place VOUT and SW on the top layer and an inner power plane for VIN.
- Also on the top layer, fit connections for the remaining pins of TPS65400-Q1 and a large top-side area filled with ground.
- Connect the top layer ground area to the internal ground layer or layers using vias at the input bypass capacitor, the output filter capacitor, and directly under the TPS65400-Q1 device to provide a thermal path from the power pad to ground.
- Tie the AGND pin directly to the power pad under the IC.
- For operation at full-rated load, the top-side ground area together with the internal ground plane must provide adequate heat dissipating area.
- Several signals paths conduct fast-changing currents or voltages that can interact with stray inductance or
 parasitic capacitance to generate noise or degrade the power supplies' performance. To help eliminate these
 problems, bypass the VIN pin to ground with a low-ESR ceramic bypass capacitor with X5R or X7R dielectric.
 Take care to minimize the loop area formed by the bypass capacitor connections, the VIN pins, and the
 ground connections. Because the SW connection is the switching node, the output inductor should be located
 close to the SW pins, and the area of the PCB conductor minimized to prevent excessive capacitive coupling.
- The output filter capacitor ground should use the same power ground trace as the VIND input bypass capacitor. Try to minimize this conductor length while maintaining adequate width.
- The compensation should be as close as possible to the COMP pins. The COMP and ROSC pins are sensitive to noise so the components associated to these pins should be located as close as possible to the IC and routed with minimal lengths of trace.
- The VFB node is a high-impedance analog node which is easier to pick noise on board. Keep FB node trace as short as possible.



11.2 Layout Example

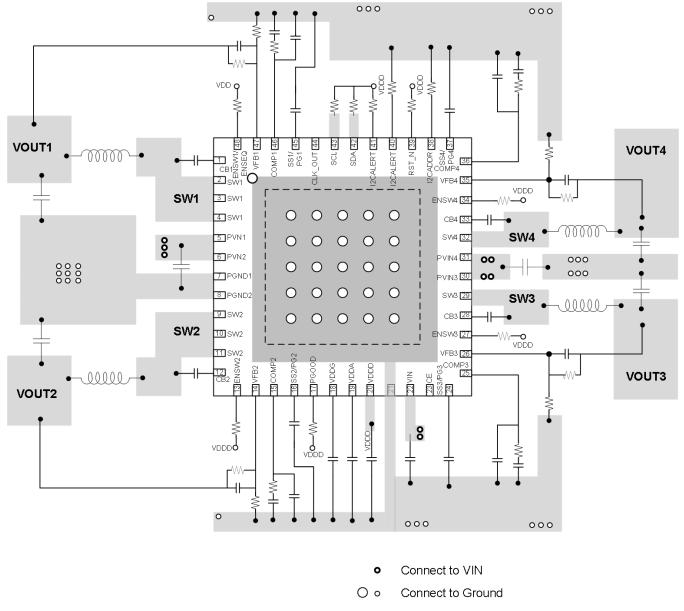


Figure 46. Layout Schematic

12 器件和文档支持

12.1 文档支持

12.1.1 相关文档

• 《PMBus 电源系统管理协议规范第 I 部分 – 一般要求、传输和电气接口》,版本 1.2,2010 年 9 月 6 日,电源管理总线应用者论坛出版 (http://pmbus.org/Specifications)。

12.1.2 相关器件

| 器件型号 | 说明 | 备注 |
|----------------|--|---|
| TPS65262 | 4.5V 至 18V 三路降压,具有双路可调 LDO | 三路降压 3A/1A/1A 输出电流,双路 LDO 100mA/200mA 输出 电流,自动电源排序 |
| TPS65263 | 4.5V 至 18V 三路降压,具有 I ² C 接口 | 三路降压 3A/2A/2A 输出电流, I ² C 控制的动态电压调节 (DVS) |
| TPS65651-1/2/3 | 4.5V 至 18V 三路降压,具有多种 PGOOD 去毛刺脉 冲时间 | 三路降压 3A/2A/2A 输出电流,支持 1s、32ms 和 256ms 三种 PGOOD 去毛刺脉冲时间,可通过外部电阻调节限流设置 |
| TPS65287 | 4.5V 至 18V 三路降压,具有电源开关和按钮控制 | 三路降压 3A/2A/2A 输出电流, 最高 2.1A USB 电源, 可通过 外部电阻进行过流设置, 可通过按钮控制智能系统上电/掉电操 作 |
| TPS65288 | 4.5V 至 18V 三路降压,具有双电源开关 | 三路降压 3A/2A/2A 输出电流, 2 个 USB 电源开关, 限流典型 值为 1.2A(出厂时提供 0.8/1/1.4/1.6/1.8/2/2.2A 多种电流供选 择调整) |

12.2 社区资源

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12.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

13 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。 这些信息是针对指定器件可提供的最新数据。 这些数据会在无通知且不 对本文档进行修订的情况下发生改变。 欲获得该数据表的浏览器版本,请查阅左侧的导航栏。

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10-Dec-2020

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| TPS65400QRGZRQ1 | ACTIVE | VQFN | RGZ | 48 | 2500 | RoHS & Green | NIPDAU | Level-3-260C-168 HR | -40 to 125 | TPS65400Q | Samples |
| TPS65400QRGZTQ1 | ACTIVE | VQFN | RGZ | 48 | 250 | RoHS & Green | NIPDAU | Level-3-260C-168 HR | -40 to 125 | TPS65400Q | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

RGZ 48

7 x 7, 0.5 mm pitch

GENERIC PACKAGE VIEW

VQFN - 1 mm max height

PLASTIC QUADFLAT PACK- NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



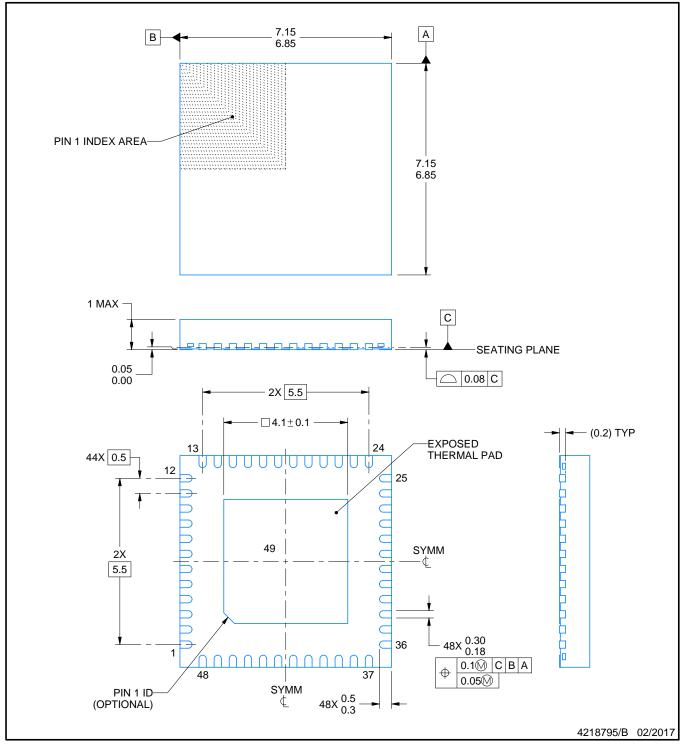
RGZ0048B



PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



RGZ0048B

EXAMPLE BOARD LAYOUT

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



 This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

 Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



RGZ0048B

EXAMPLE STENCIL DESIGN

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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